

TPS549D22EVM-784, 40-A Single Synchronous Step-Down Converter With Full Differential Sense and PMBus™

This user's guide describes the characteristics, operation, and use of the TPS549D22 Evaluation Module (EVM). The user's guide includes test information, descriptions, and results. A complete schematic diagram, printed-circuit board layouts, and bill of materials are also included in this document. Throughout this user's guide, the abbreviations EVM, TPS549D22EVM, and the term evaluation module are synonymous with the TPS549D22EVM-784, unless otherwise noted.

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1 Introduction

The PWR784EVM evaluation module uses the TPS549D22 device. The TPS549D22 is a highly integrated synchronous buck converter that is designed for up to 40-A current output.

2 Description

The PWR784EVM is designed as a single output DC-DC converter that demonstrates the TPS549D22 in a typical low-voltage application while providing a number of test points to evaluate the performance. It uses a nominal 12-V input bus to produce a regulated 1-V output at up to 40-A load current.

2.1 Typical End-User Applications

- Enterprise Storage, SSD, NAS
- Wireless and Wired Communication Infrastructure
- Industrial PCs, Automation, ATE, PLC, Video Surveillance
- Enterprise Server, Switches, Routers
- ASIC, SoC, FPGA, DSP Core and I/O Rails

2.2 EVM Features

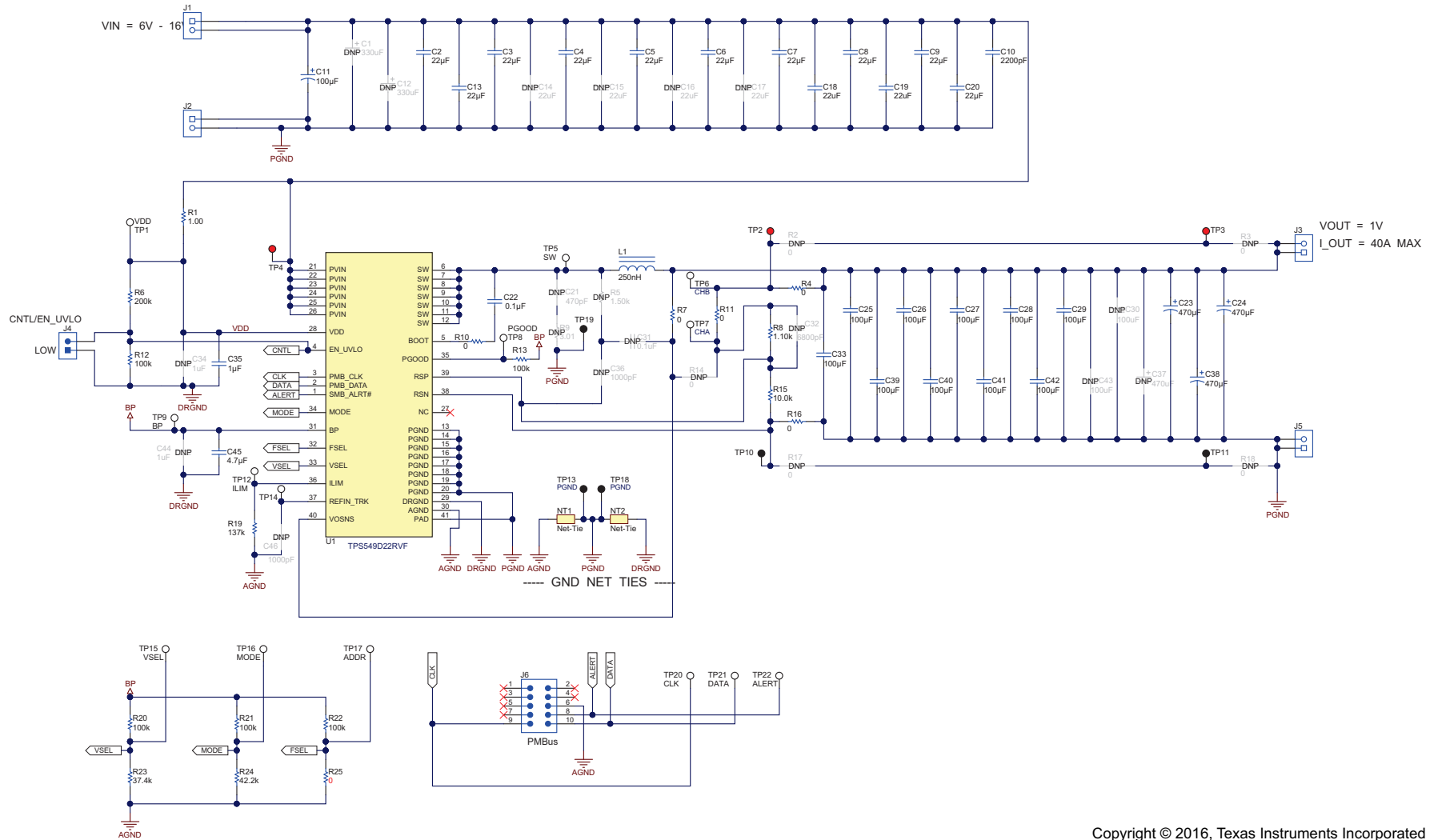
- Regulated 1-V output up to 40-A, steady-state output current
- Convenient test points for probing critical waveforms
- PMBus™ connector for easy connection with the TI USB adapter

3 EVM Electrical Performance Specifications

Table 1. PWR-784EVM Electrical Performance Specifications

| Parameter | Test Conditions | Min | Typ | Max | Units |
|---------------------------------|--|-----|------|-----|------------------|
| Input Characteristics | | | | | |
| Voltage range | V_{IN} tied to VDD | 5 | 12 | 16 | V |
| Maximum input current | $V_{IN} = 12\text{ V}$, $I_O = 40\text{ A}$ | | | 12 | A |
| No load input current | $V_{IN} = 12\text{ V}$, $I_O = 0\text{ A}$ | | 60 | | mA |
| Output Characteristics | | | | | |
| V_{OUT} Output voltage | Output current = 10 A | | 1 | | V |
| I_{OUT} Output load current | $I_{OUT(min)}$ to $I_{OUT(max)}$ | 0 | | 40 | A |
| Output voltage regulation | Line regulation: input voltage = 5 V to 16 V | | 0.5% | | |
| | Load regulation: output current = 0 A to $I_{OUT(max)}$ | | 0.5% | | |
| V_{OUT} Output voltage ripple | $V_{IN} = 12\text{ V}$, $I_{OUT} = 40\text{ A}$ | | 10 | | mV _{pp} |
| V_{OUT} Output overcurrent | | | 46 | | A |
| Systems Characteristics | | | | | |
| Switching frequency | F_{SW} | | 650 | | kHz |
| V_{OUT} Peak efficiency | $V_{IN} = 12\text{ V}$, $I_O = 18\text{ A}$, $F_{SW} = 650\text{ kHz}$ | | 89% | | |
| Operating temperature | T_{oper} | 0 | | 105 | °C |

4 Schematic



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Figure 1. PWR-784EVM Schematic

5 Test Setup

5.1 Test and Configuration Software

To change any of the default configuration parameters on the EVM, it is necessary to obtain the TI Fusion Digital Power Designer software. This can be downloaded from the TI website.

5.1.1 Description

The Fusion Digital Power Designer is the graphical user interface (GUI) used to configure and monitor the Texas Instruments TPS549D22 power converter installed on this evaluation module. The application uses the PMBus protocol to communicate with the controller over serial bus by way of a TI USB adapter. This adapter can be purchased at <http://www.ti.com/tool/usb-to-gpio>.

NOTE: The TI USB adapter must be purchased separately. It is not included with this EVM kit.

5.1.2 Features

Some of the tasks performed with the GUI include:

- Turn on or off the power supply output, either through the hardware control line or the PMBus operation command.
- Monitor status registers. Items such as input voltage, output voltage, output current, temperature, and warnings and faults are continuously monitored and displayed by the GUI.
- Configure common operating characteristics such as VOUT, UVLO, soft-start time, warning and fault thresholds, fault response, and ON/OFF.

This software is available for download at http://www.ti.com/tool/fusion_digital_power_designer.

6 Test Equipment

Voltage Source: The input voltage source V_{IN} must be a 0-V to 18-V variable DC source capable of supplying at least 12 A_{DC} .

Multimeters: It is recommended to use two separate multimeters [Figure 2](#). One meter is used to measure V_{IN} and one to measure V_{OUT} .

Output Load: A variable electronic load is recommended for testing [Figure 2](#). It must be capable of 40 A at voltages as low as 0.6 V.

Oscilloscope: An oscilloscope is recommended for measuring output noise and ripple. Output ripple must be measured using a tip-and-barrel method or better as shown in [Figure 3](#). The scope must be adjusted to 20-MHz bandwidth, AC coupling at 50 mV/division, and must be set to 1- μ s/division.

Fan: During prolonged operation at high loads, it may be necessary to provide forced air cooling with a small fan aimed at the EVM. Temperature of the devices on the EVM must be maintained below 105°C.

USB-to-GPIO Interface Adapter: A communications adapter is required between the EVM and the host computer. This EVM was designed to use TI's USB-to-GPIO adapter. Purchase this adapter at <http://www.ti.com/tool/usb-to-gpio>.

Recommended Wire Gauge: The voltage drop in the load wires must be kept as low as possible in order to keep the working voltage at the load within its operating range. Use the AWG 14 wire (2 wires parallel for VOUT positive and 2 wires parallel for the VOUT negative) of no more than 1.98 feet between the EVM and the load. This recommended wire gauge and length should achieve a voltage drop of no more than 0.2 V at the maximum 40-A load.

7 PWR-784EVM

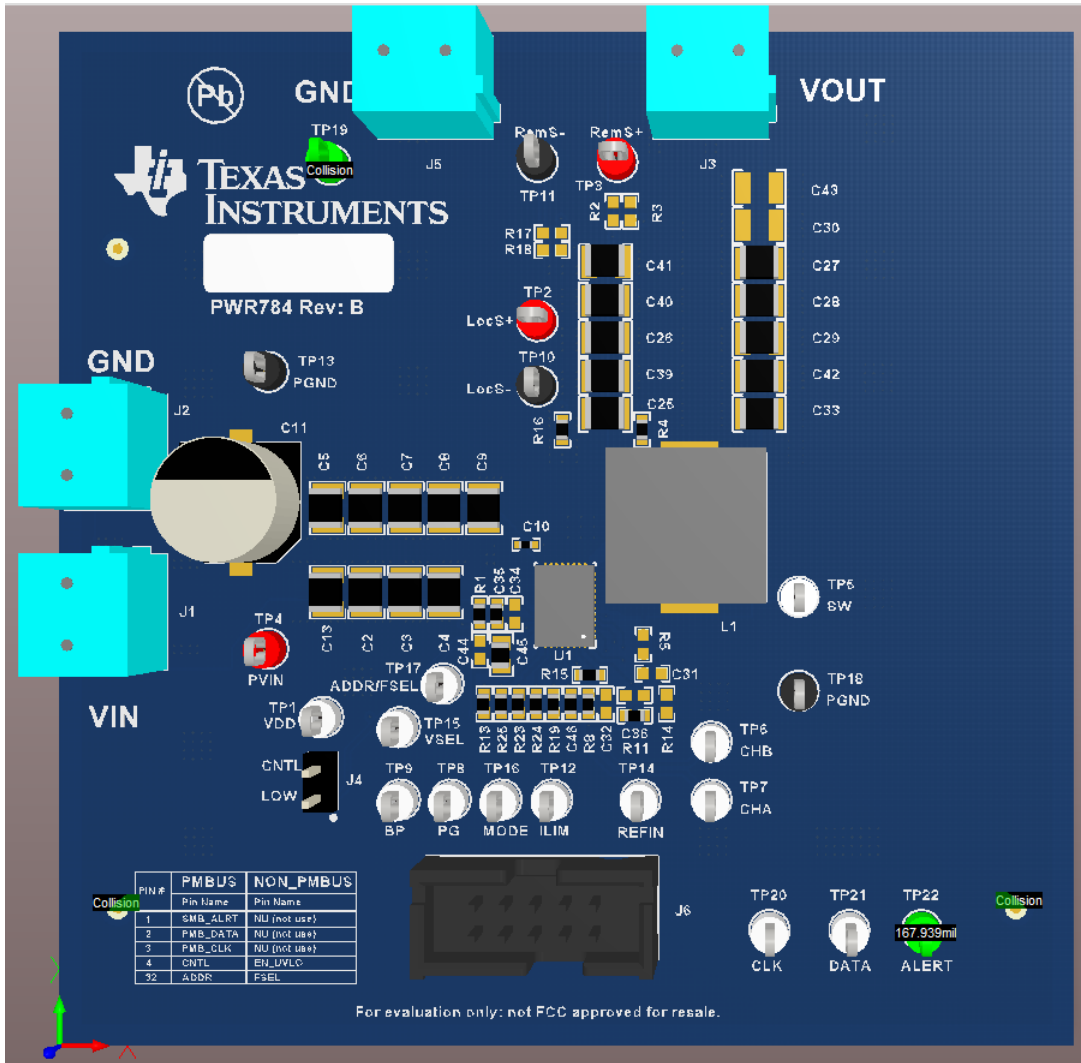
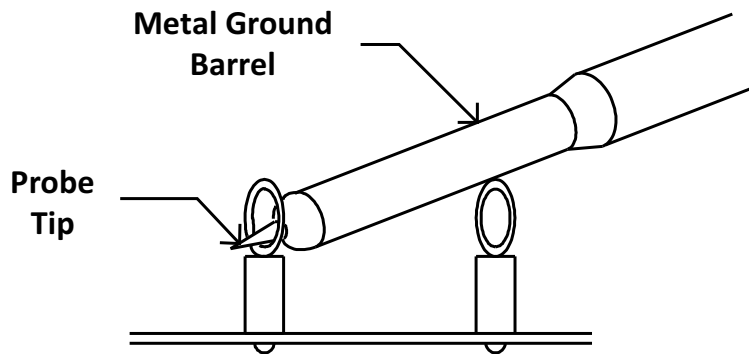


Figure 2. PWR-784EVM Overview



Tip and Barrel V_{OUT} Ripple Measurement

Figure 3. Tip and Barrel Measurement

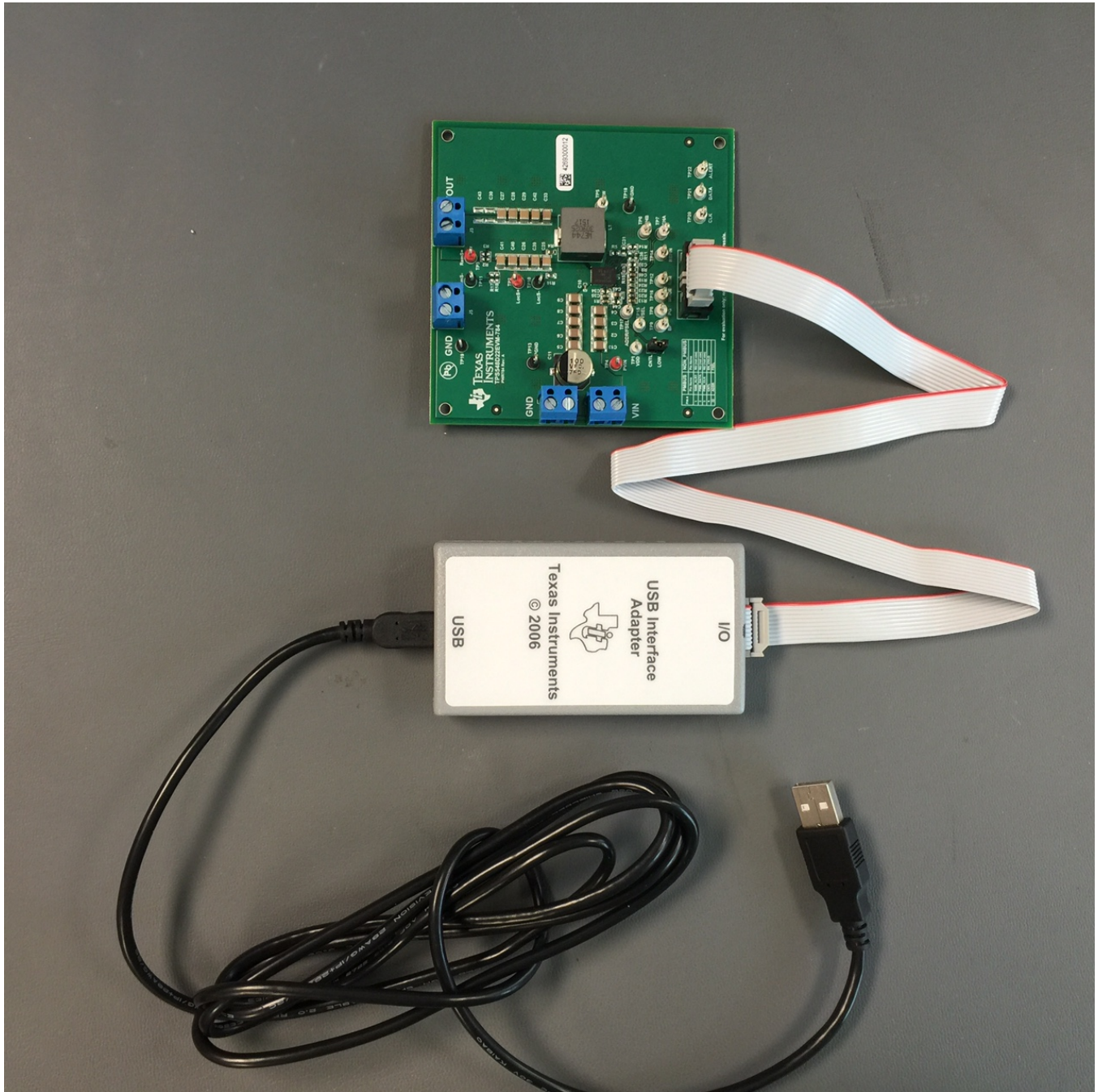


Figure 4. EVM and USB Interface Adapter

8 List of Test Points, Jumpers, and Switch

Table 2 lists the test points and their descriptions.

Table 2. Test Point Functions

| Item | Type | Name | Description |
|------|--------------|-----------|--|
| TP5 | T-H loop | SW | Power supply Switch node |
| TP7 | T-H loop | CH-A | Measure loop stability |
| TP6 | T-H loop | CH-B | Measure loop stability |
| TP2 | T-H loop | LocS+ | Sense VOUT + locally across C5. Use for efficiency and ripple measurements |
| TP10 | T-H loop | LocS- | Sense VOUT- locally across C5. Use for efficiency and ripple measurements |
| TP3 | T-H loop | RemS+ | Remote sense + |
| TP11 | T-H loop | RemS- | Remote sense - |
| TP4 | T-H loop | PVIN | Sense VIN + across C10 |
| TP13 | T-H loop | PGND | Sense VIN - across C10 |
| TP1 | T-H loop | VDD | Supplies the internal circuitry |
| TP17 | T-H loop | FSEL | Monitor the FSEL external resistor divider ratio during initial power up. |
| TP15 | T-H loop | VSEL | Monitor the VSEL external resistor divider ratio during initial power up. |
| TP9 | T-H loop | BP | LDO output |
| TP8 | T-H loop | PG | Power good |
| TP16 | T-H loop | MODE | Monitor the MODE external resistor divider ratio during initial power up. |
| TP12 | T-H loop | ILIM | Program over-current limit. |
| TP14 | T-H loop | RESV_TRK | Do not connect. |
| TP19 | T-H loop | PGND | Common GND |
| TP18 | T-H loop | PGND | Common GND |
| TP20 | T-H loop | PMB_CLK | Clock input for the PMBus interface. |
| TP21 | T-H loop | PMB_DATA | Data I/O for the PMBus interface. |
| TP22 | T-H loop | SMB_ALRT# | Alert output for the PMBus interface. |
| JP4 | 2-pin jumper | CNTL | Shunts control pin to GND |

9 EVM Configuration Using the Fusion GUI

The TPS549D22 installed on this EVM leave the factory pre-configured. See [Table 3](#) for a short list of key factory configuration parameters as obtained from the configuration file.

Table 3. Key Factory Configuration Parameters

| Cmd ID With Phase | Cmd Code Hex | Encoded Hex [HiByte LoByte] | Comments |
|--------------------|--------------|-----------------------------|--|
| CAPABILITY | 0x19 | 0xD0 | Max Bus: 1000 khz; PEC: Yes; SMBALERT#: Yes |
| MFR_00 | 0xD0 | 0x00 | 0 |
| MFR_01 (PGOOD_DLY) | 0xD1 | 0x12 | PGD:1024?s [010b], POD:1024?s [010b] |
| MFR_02 | 0xD2 | 0x13 | CM: True, HICLOFF: True, SST: 0x00, FORCESKIPSS: True, SEQ: False, TRK: False |
| MFR_03 | 0xD3 | 0x93 | FS:625kHz [011b], RCSP:R ? 1 [01b], DCAP3:True |
| MFR_04 | 0xD4 | 0x80 | DCAP3_Offset:0mV [00b], DCAP3_Offset_Sel:True |
| MFR_06 | 0xD6 | 0x05 | VDDUVLO:4.25V [101b] |
| MFR_07 | 0xD7 | 0x8F | VTRKIN:1.25V [1111b], TRKOPTION:False, SPARE:False, VPBAD:True |
| MFR_33 | 0xF1 | 0x00 | 0 |
| MFR_42 | 0xFA | 0x00 | 0 |
| MFR_44 | 0xFC | 0x0201 | ID: 0x020 (TPS549C20), Revision: 0x1 |
| ON_OFF_CONFIG | 0x02 | 0x17 | Mode: CONTROL Pin Only; Control: Active High, Turn off Immediately |
| OPERATION | 0x01 | 0x00 | Operation is not used to enable regulatio; Unit: ImmediateOff; Margin: None |
| STATUS_BYTE | 0x78 | 0x00 | Status: Output Off, Vout OV Fault, IOUT OC Fault, Vin UV Fault, Temperature, CML |
| STATUS_CML | 0x7E | 0x00 | Status: Invalid Command, Invalid Data, PEC Fault, Other Comms Fault |
| STATUS_IOUT | 0x7B | 0x00 | Status: Iout OC Fault, Iout OC Fault with LV Shutdown, Iout UC Fault |
| STATUS_VOUT | 0x7A | 0x00 | Status: Vout OV Fault, OV Warning, UV Fault, UV Warning |
| VOUT_COMMAND | 0x21 | 0x01CD | VOUT_COMMAND=0.900 V |
| VOUT_MARGIN_HIGH | 0x25 | 0x0266 | VOUT_MARGIN_HIGH=1.199 V |
| VOUT_MARGIN_LOW | 0x26 | 0x0266 | VOUT_MARGIN_LOW=1.199 V |
| WRITE_PROTECT | 0x10 | 0x00 | Enable Writes To All Commands |

If it is desired to configure the EVM to settings other than the factory settings shown in Table 3, the TI Fusion Digital Power Designer software can be used for reconfiguration. It is necessary to have input voltage applied to the EVM prior to launching the software so that the TPS549D22 installed is active and able to respond to the GUI and the GUI can recognize the device.

10 Test Procedure

10.1 Line and Load Regulation Measurement Procedure

Use the following procedures for line and load regulation measurement.

1. Connect V_{OUT} to J3 and V_{OUT_GND} to J5 [Figure 2](#).
2. Ensure that the electronic load is set to draw 0 A_{DC}.
3. Connect V_{IN} to J1 and V_{IN_GND} to J2 [Figure 2](#).
4. Connect the USB interface adapter as shown in [Figure 4](#).
5. Increase V_{IN} from 0 V to 12 V using the digital multimeter to measure input voltage.
6. Launch the Fusion GUI software. See the screen shots in [Section 12](#) for more information.
7. Configure the EVM operating parameters as desired.
8. Use the other digital multimeter or the oscilloscope to measure output voltage V_{OUT} at TP2 and TP10 as you vary the external voltage source.

Table 4. List of Test Points for Line and Load Measurements

| Test Point | Node Name | Description |
|------------|-----------|--|
| TP2 | LocS+ | Sense V _{OUT} + locally across C5. Use for efficiency and ripple measurements |
| TP10 | LocS- | Sense V _{OUT} - locally across C5. Use for efficiency and ripple measurements |
| TP4 | PVIN | Sense V _{IN} + across C10 |
| TP13 | PGND | Sense V _{IN} - across C10 |

9. Vary the load from 0 A_{DC} to maximum rated output 40 A_{DC}. V_{OUT} must remain in regulation as defined in [Table 1](#).
10. Vary V_{IN} from 5 V to 16 V. V_{OUT} must remain in regulation as defined in [Table 1](#).
11. Decrease the load to 0 A.
12. Decrease V_{IN} to 0 V or turn off the supply.

10.2 Efficiency

To measure the efficiency of the power train on the EVM, it is important to measure the voltages at the correct location. This is necessary because otherwise the measurements will include losses in efficiency that are not related to the power train itself. Losses incurred by the voltage drop in the copper traces and in the input and output connectors are not related to the efficiency of the power train, and they must not be included in efficiency measurements.

Table 5. List of Test Points for Efficiency Measurements

| Test Point | Node Name | Description |
|------------|-----------|--|
| TP2 | LocS+ | Sense V _{OUT} + locally across C5. Use for efficiency and ripple measurements |
| TP10 | LocS- | Sense V _{OUT} - locally across C5. Use for efficiency and ripple measurements |
| TP4 | PVIN | Sense V _{IN} + across C10 |
| TP13 | PGND | Sense V _{IN} - across C10 |

Input current can be measured at any point in the input wires, and output current can be measured anywhere in the output wires of the output being measured. Using these measurement points result in efficiency measurements that do not include losses due to the connectors and PCB traces.

10.3 Equipment Shutdown

1. Reduce the load current to 0 A.
2. Reduce input voltage to 0 V.
3. Shut down the external fan if in use.
4. Shut down equipment.

11 Performance Data and Typical Characteristic Curves

Figure 5 through Figure 19 present typical performance curves for the PWR-784EVM.

11.1 Efficiency

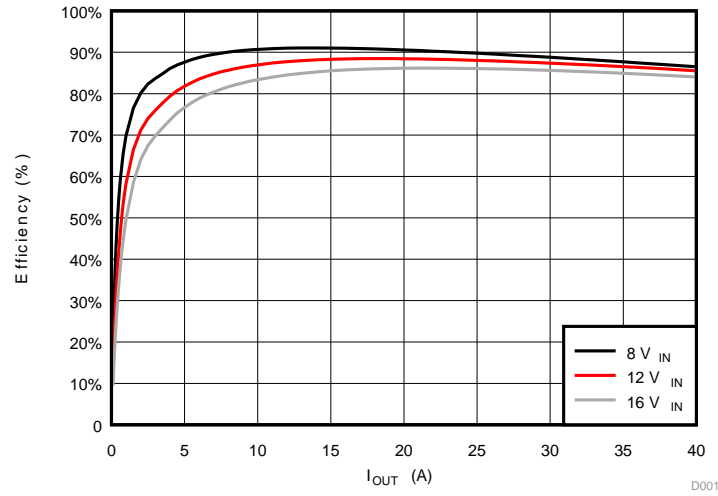


Figure 5. Efficiency of 1-V Output vs Load

11.2 Load Regulation

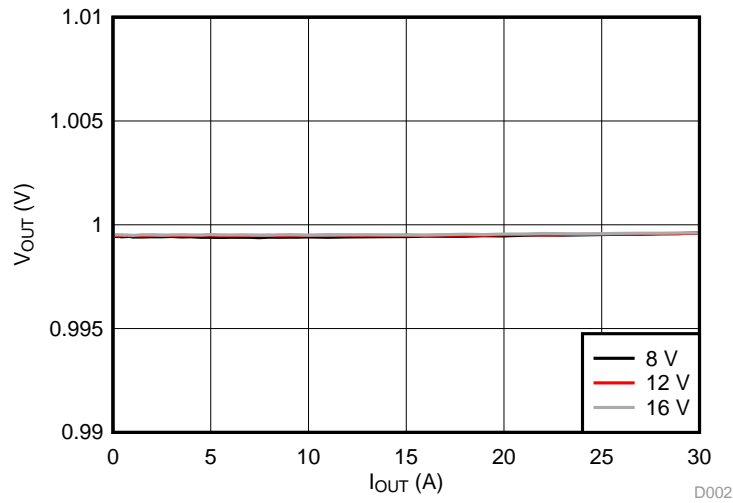


Figure 6. Load Regulation of 1-V Output

11.3 Line Regulation

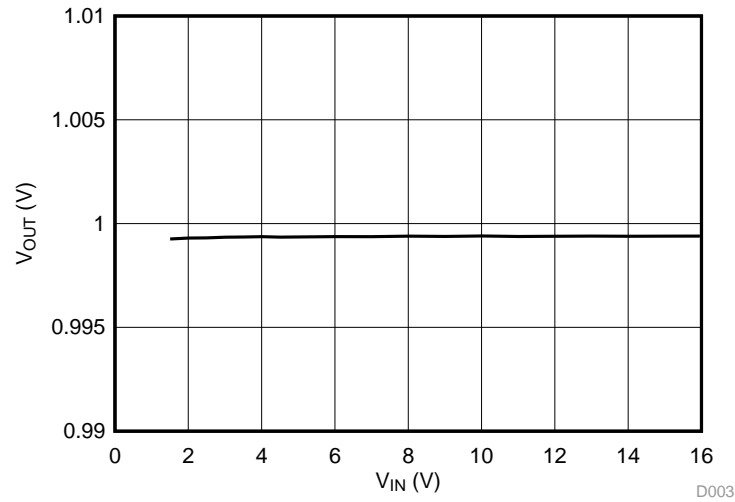


Figure 7. Line Regulation of 1-V Output



Figure 8. PMBus V_{OUT} Step-Up = 0.6 V to 1.2 V at 0 A



Figure 9. PMBus V_{OUT} Step-Down = 1.2 V to 0.6 V at 0 A



Figure 10. PMBus V_{OUT} Step-Up = 0.6 V to 1.2 V at 40 A

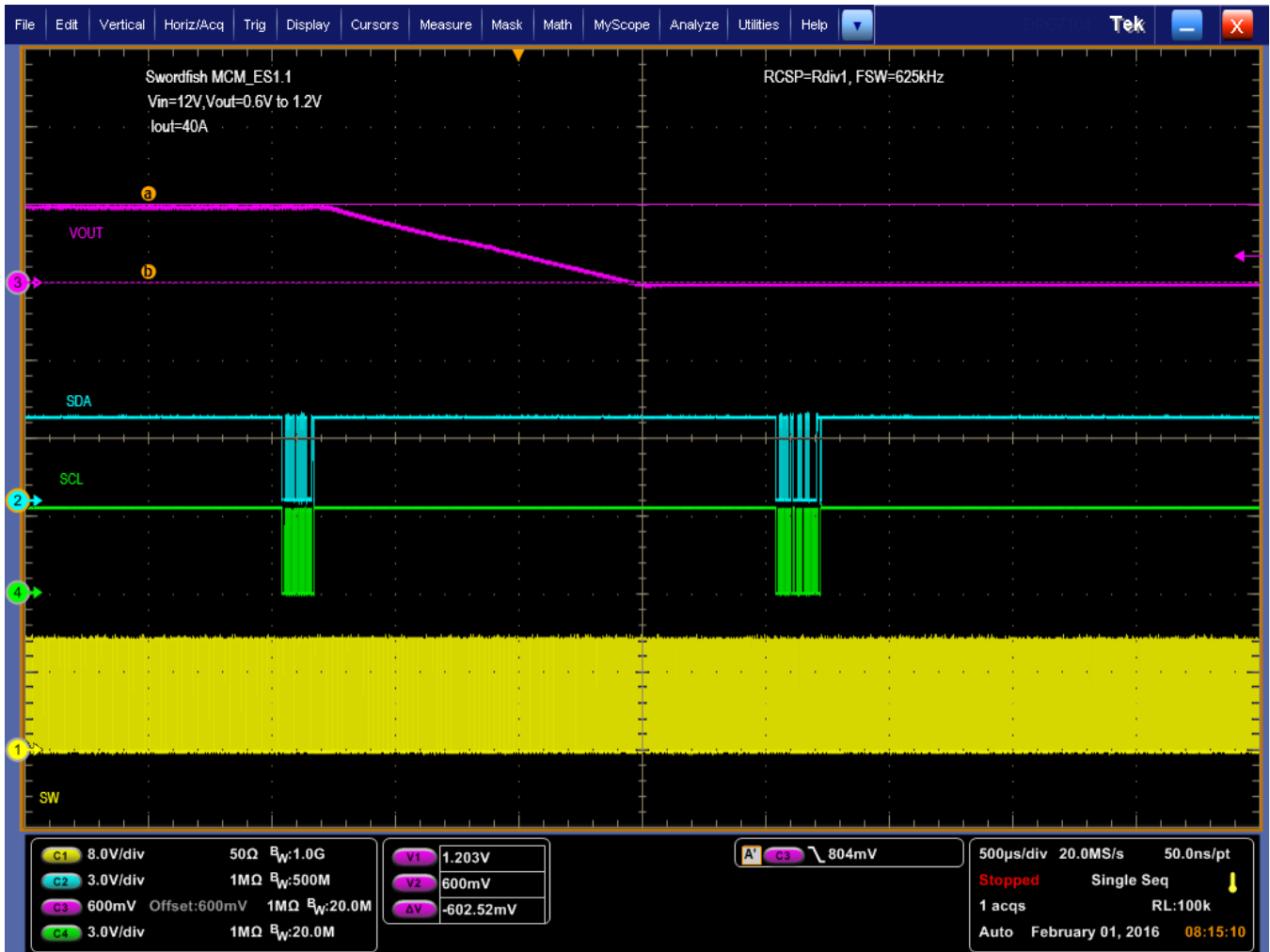


Figure 11. PMBus V_{OUT} Step-Down = 1.2 V to 0.6 V at 40 A

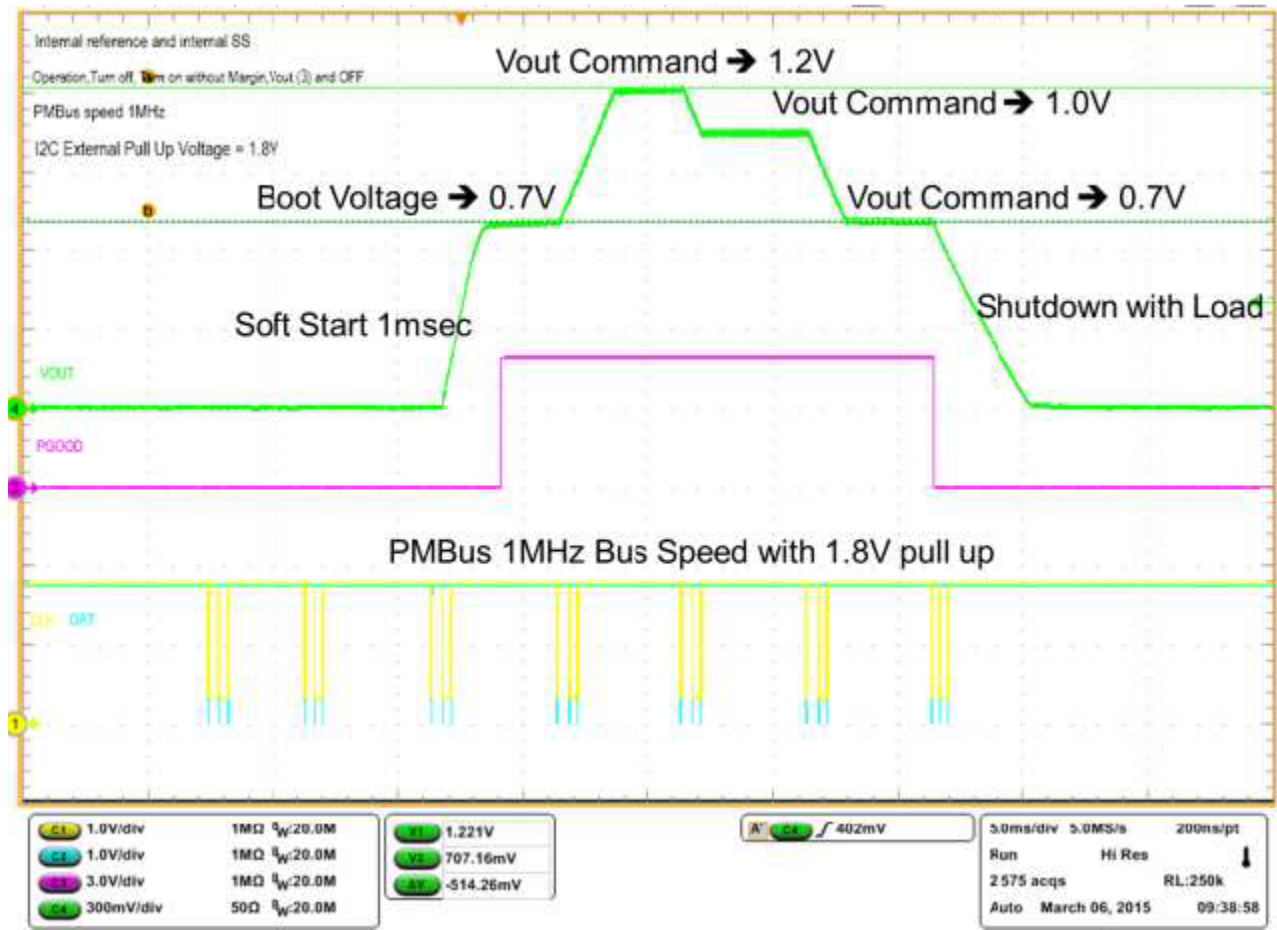


Figure 12. PMBUS Multiple Commands

11.4 Transient Response

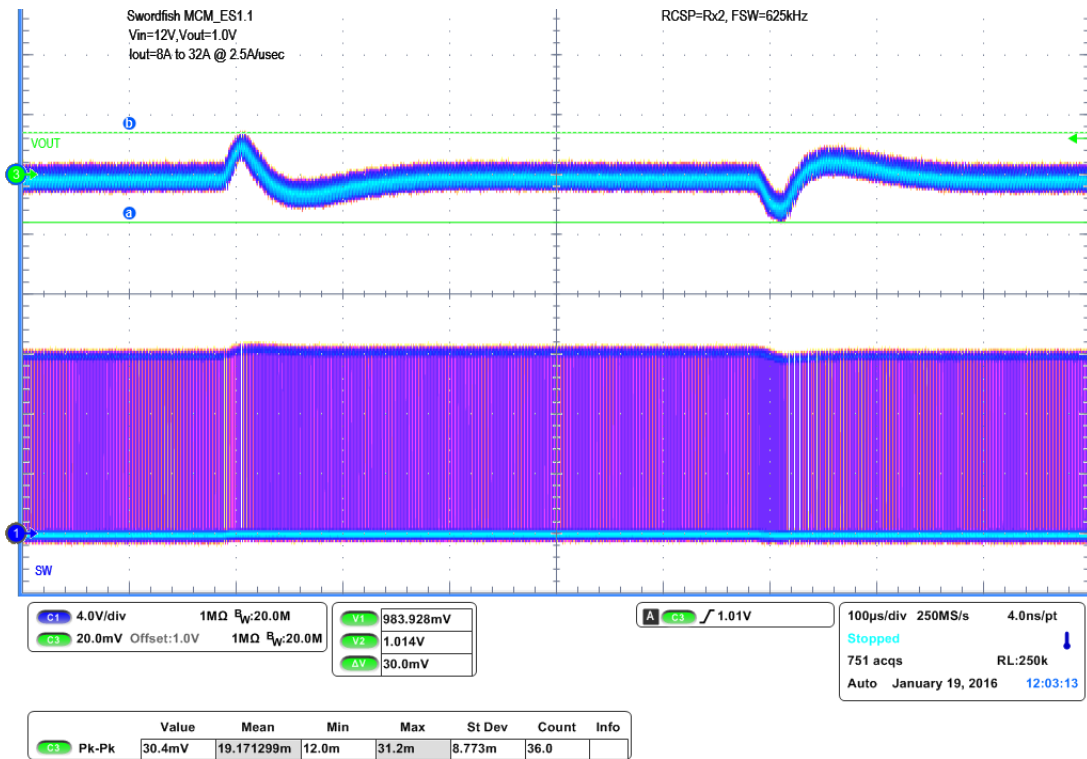


Figure 13. Transient Response of 1-V Output at 12 V_{IN}, Transient is 8 A to 32 A, 2.5 A/µs

11.5 Output Ripple

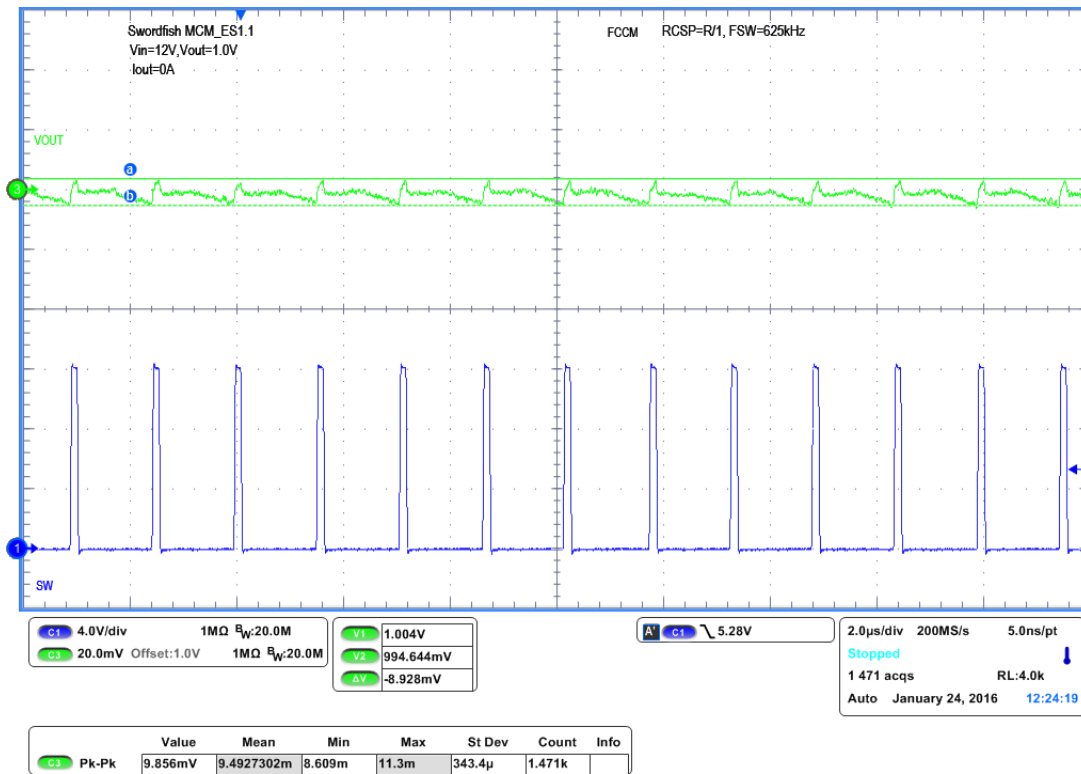


Figure 14. Output Ripple and SW Node of 1-V Output at 12 V_{IN}, 0-A Output

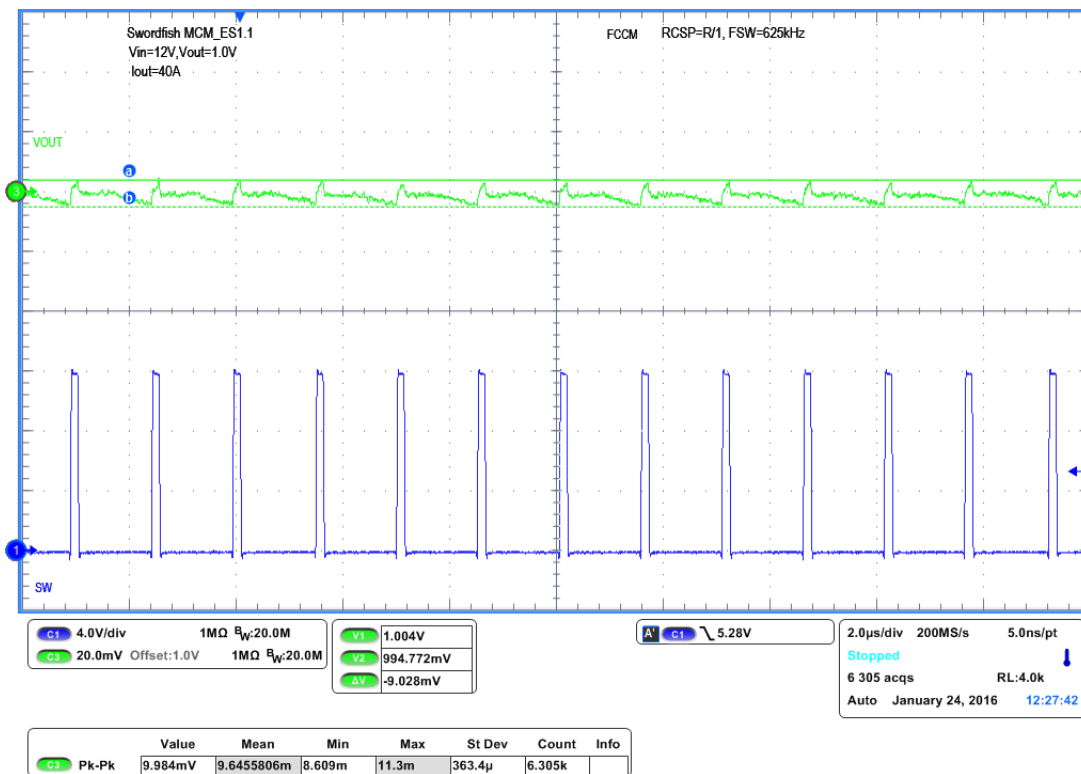


Figure 15. Output Ripple and SW Node of 1-V Output at 12 V_{IN}, 40-A Output

11.6 Control On

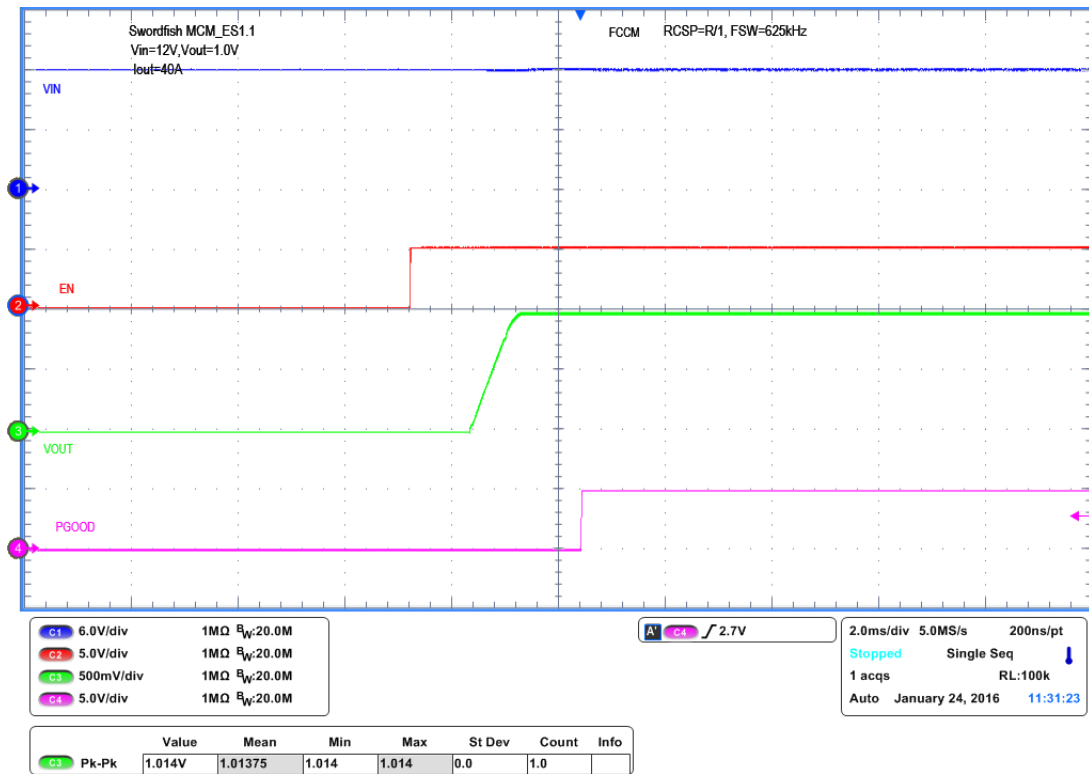


Figure 16. Start up from Control, 1-V Output at 12 V_{IN}, 40-A Output

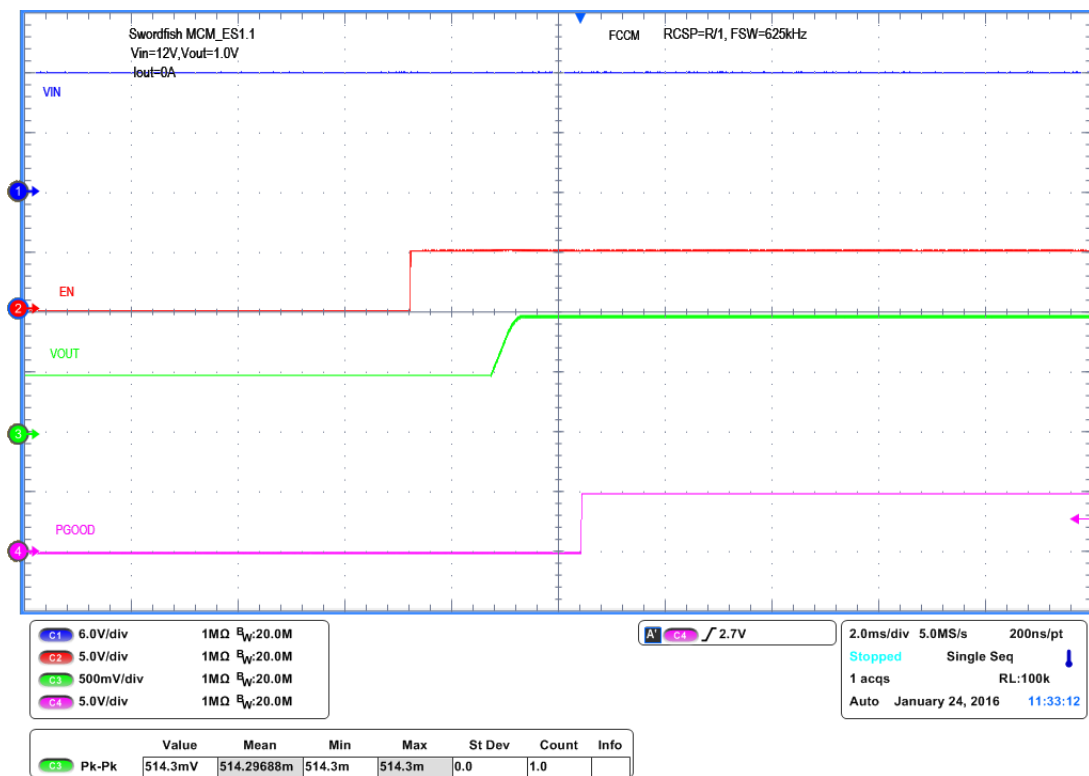


Figure 17. 0.5-V Pre-bias start up from Control, 1-V Output at 12 V_{IN}, 40-A Output

11.7 Control Off

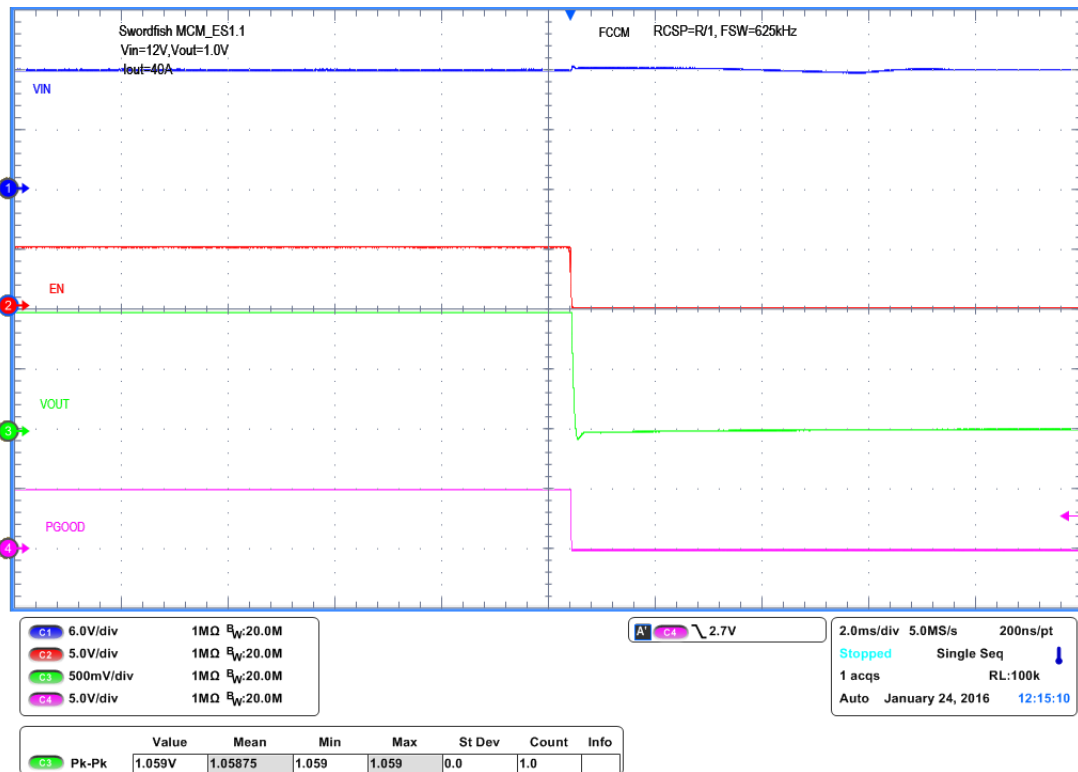


Figure 18. Soft Stop from Control, 1-V Output at 12 V_{IN}, 40-A Output

11.8 Thermal Image

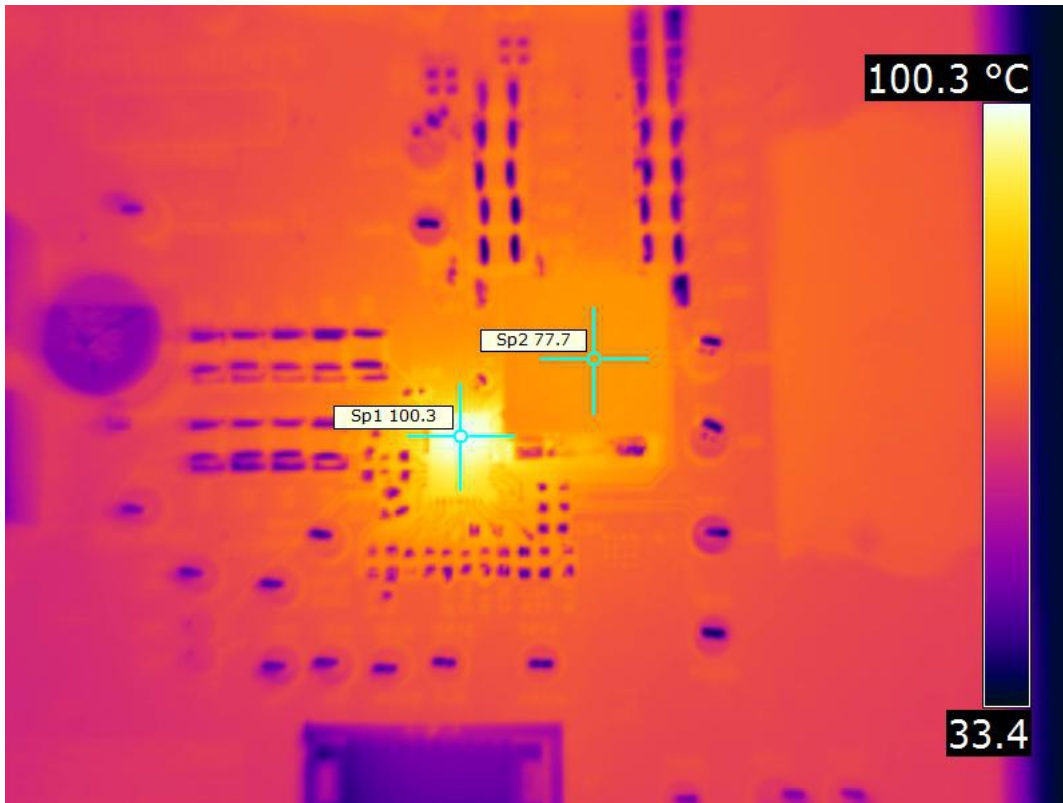


Figure 19. Thermal Image at 1-V Output at 12 V_{IN}, 40-A Output

12 Fusion GUI

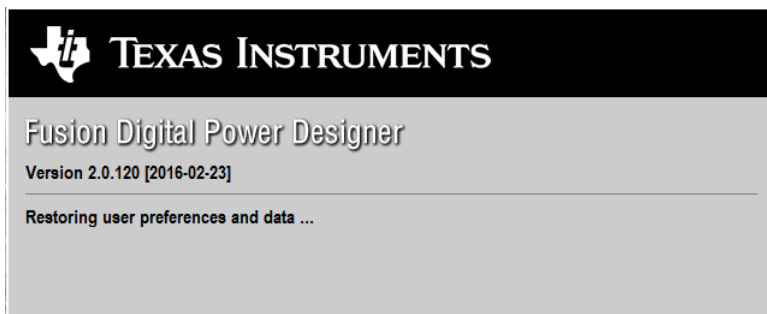


Figure 20. First Window at Fusion Launch



Figure 21. Scan Finds Device Successfully



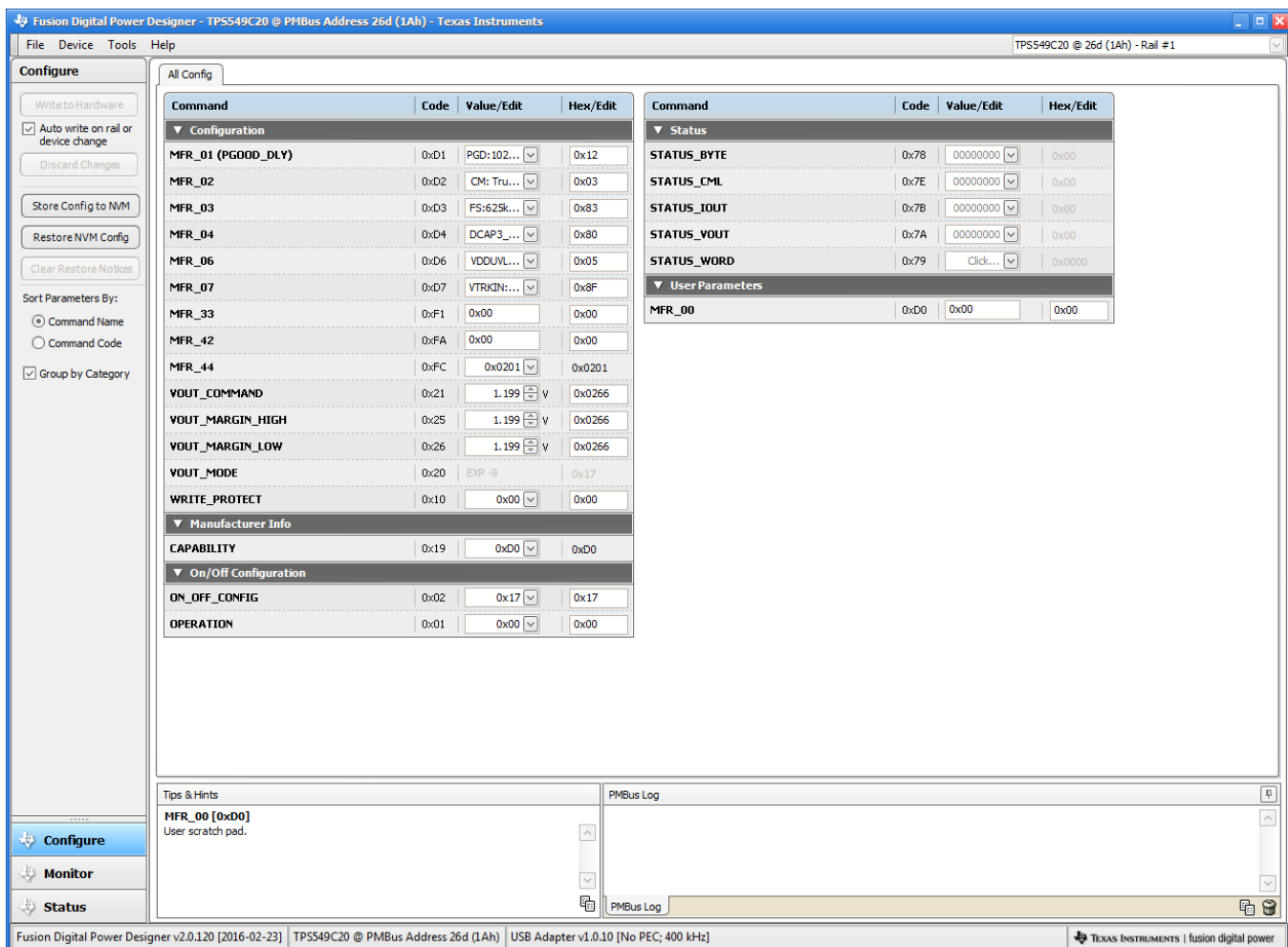
Figure 22. Software Launch Continued



Figure 23. Software Launch Continued

Use the *All Config* tab to configure all of the configurable parameters (Figure 24). The screen also shows other details like hexadecimal (hex) encoding. Use this screen to configure:

- Power Good Delay
- Power On Delay
- Mode Settings
- Frequency, RAMP, DCAP3
- VDD UVLO
- On/Off Configuration
- Track and Sequencing
- Write Protect
- VOUT Command Voltage
- VOUT Margin
- Operation



**Figure 24. First Screen After Successful Launch
Configure: Limits and On/Off**

Changing the frequency prompts a pop-up window with details of the options [Figure 25](#)).

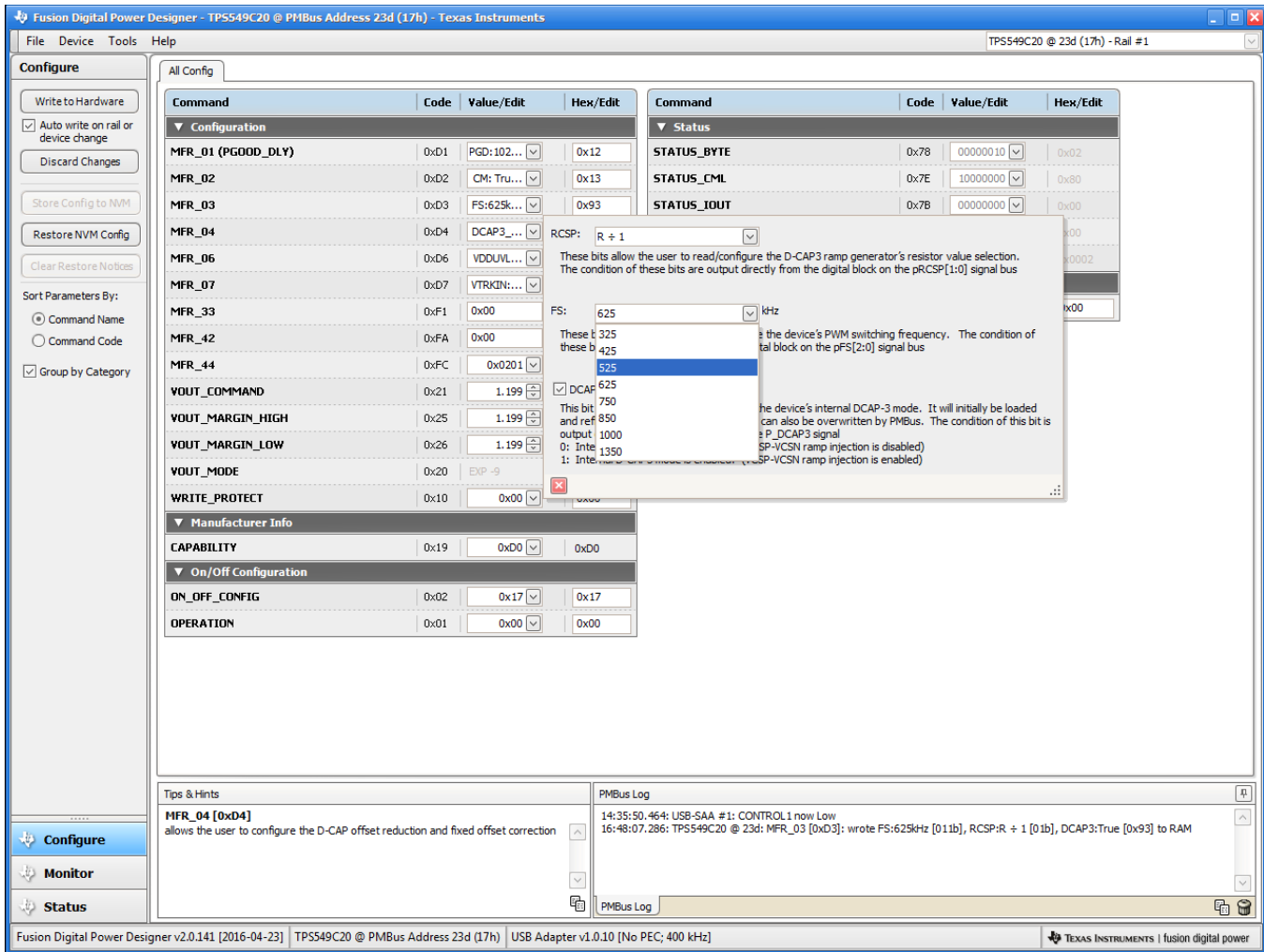


Figure 25. Configure: Frequency- FS Configuration Pop-up

After a change is selected, orange **U** icon is displayed to offer *Undo Change* option. Change is not retained until either *Write to Hardware* or *Store Config to NVM* is selected. When *Write to Hardware* is selected, change is committed to volatile memory and defaults back to previous setting on input power cycle. When *Store Config to NVM* is selected, change is committed to nonvolatile memory and becomes the new default (Figure 26).

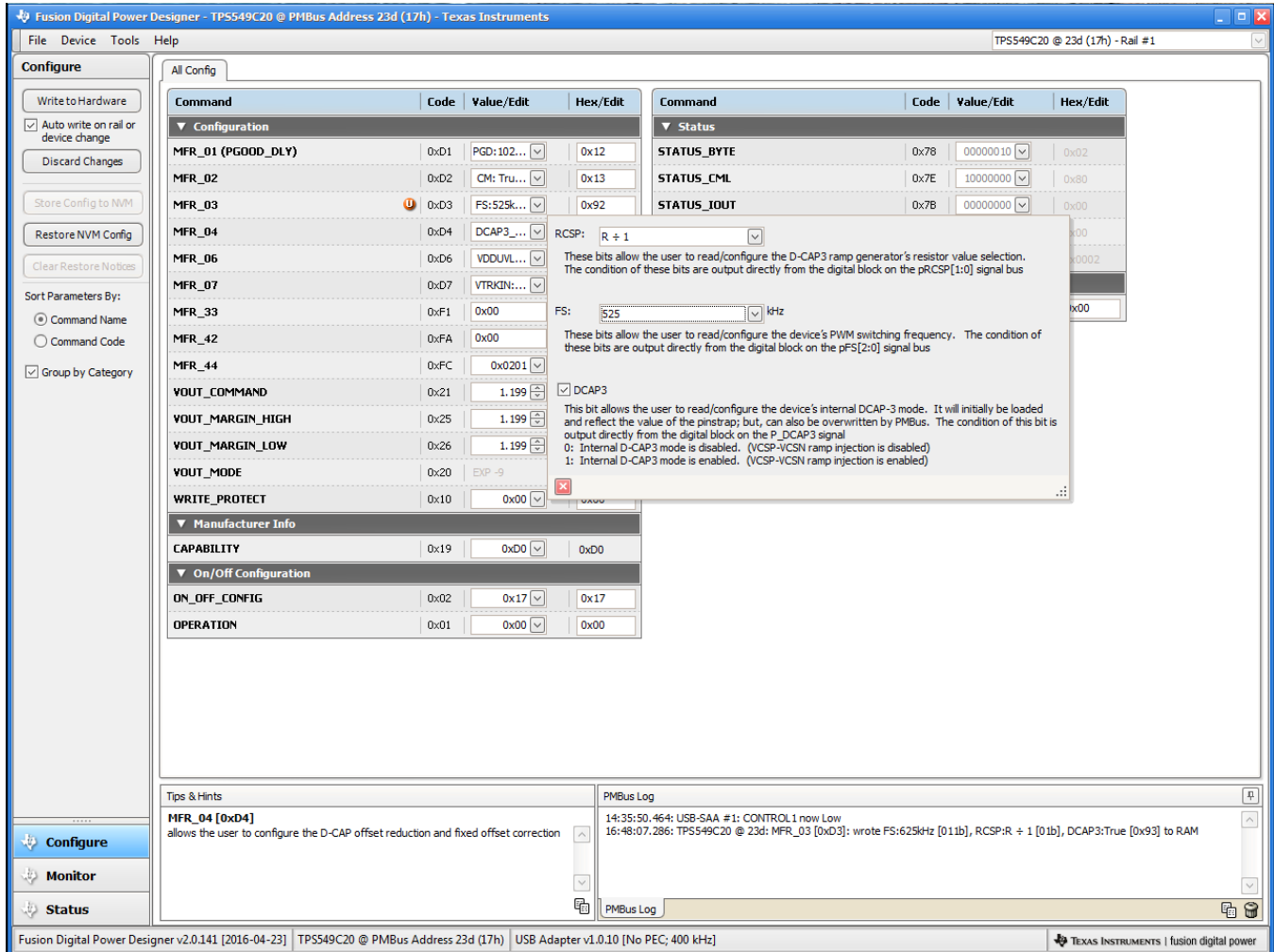


Figure 26. Configure: Frequency- FS Config Pop-Up with Change

After making changes to one or more configurable parameters, the changes can be committed to nonvolatile memory by selecting *Store Config to NVM*. This action prompts a *confirm selection* pop-up, and if confirmed, the changes are committed to nonvolatile memory (Figure 27).

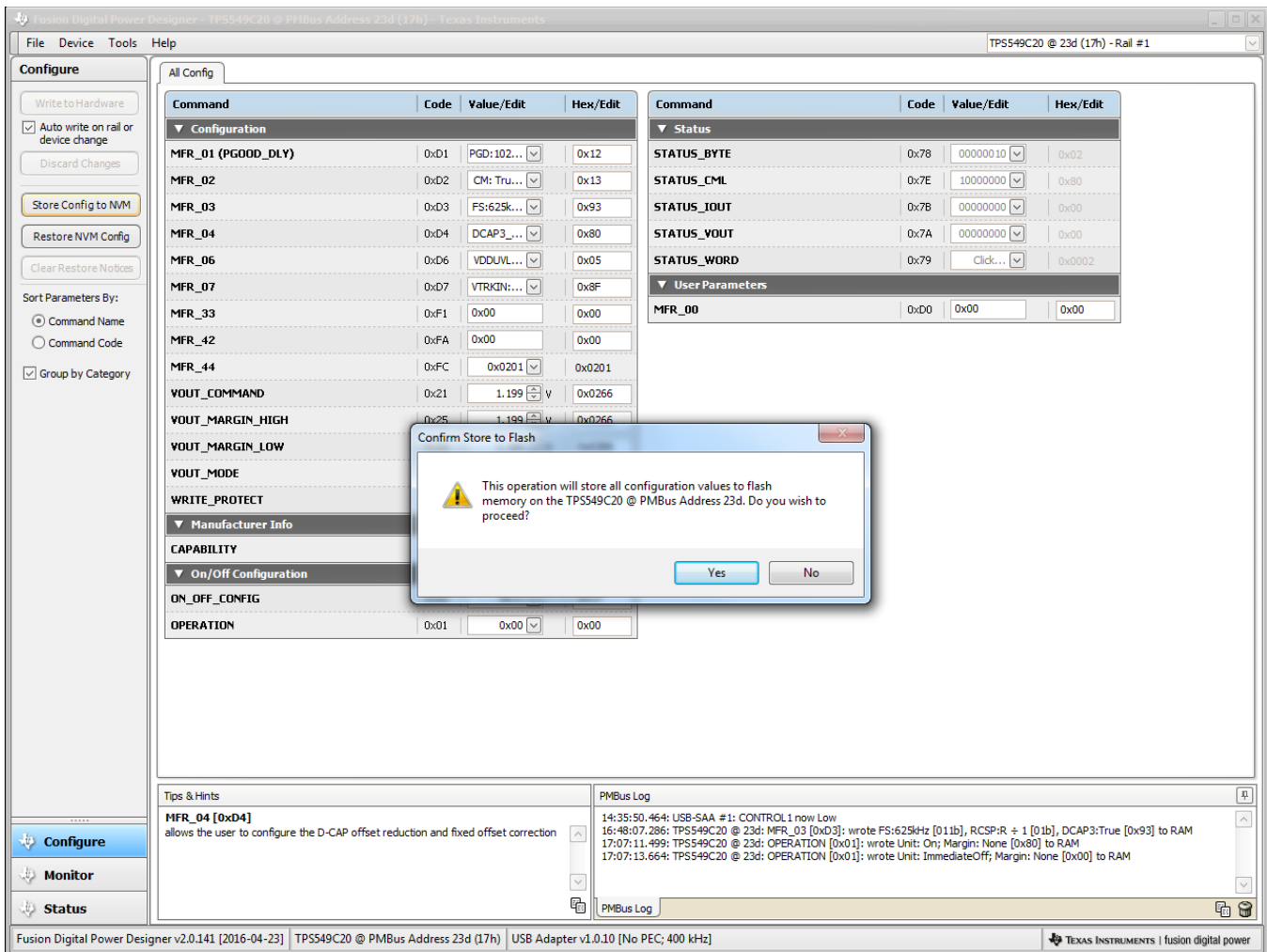


Figure 27. Configure: Store Config to NVM

In the lower left corner, the different view screens can be changed. The view screens can be changed between *Configure*, *Monitor* and *Status* as needed (Figure 28).

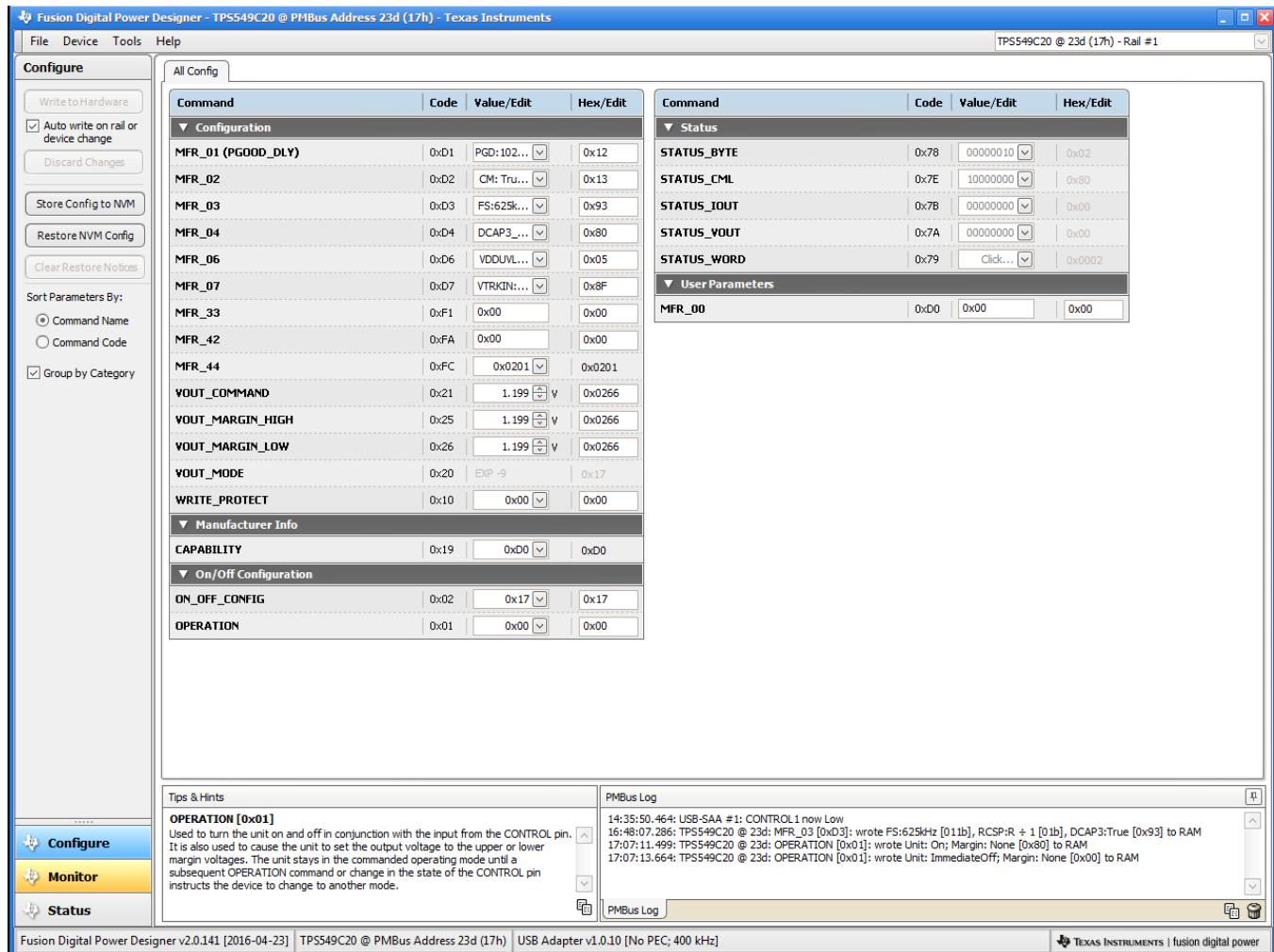


Figure 28. Change View Screen to Monitor Screen

Selecting *System Dashboard* from mid-left screen adds a new window which displays system-level information (Figure 29).

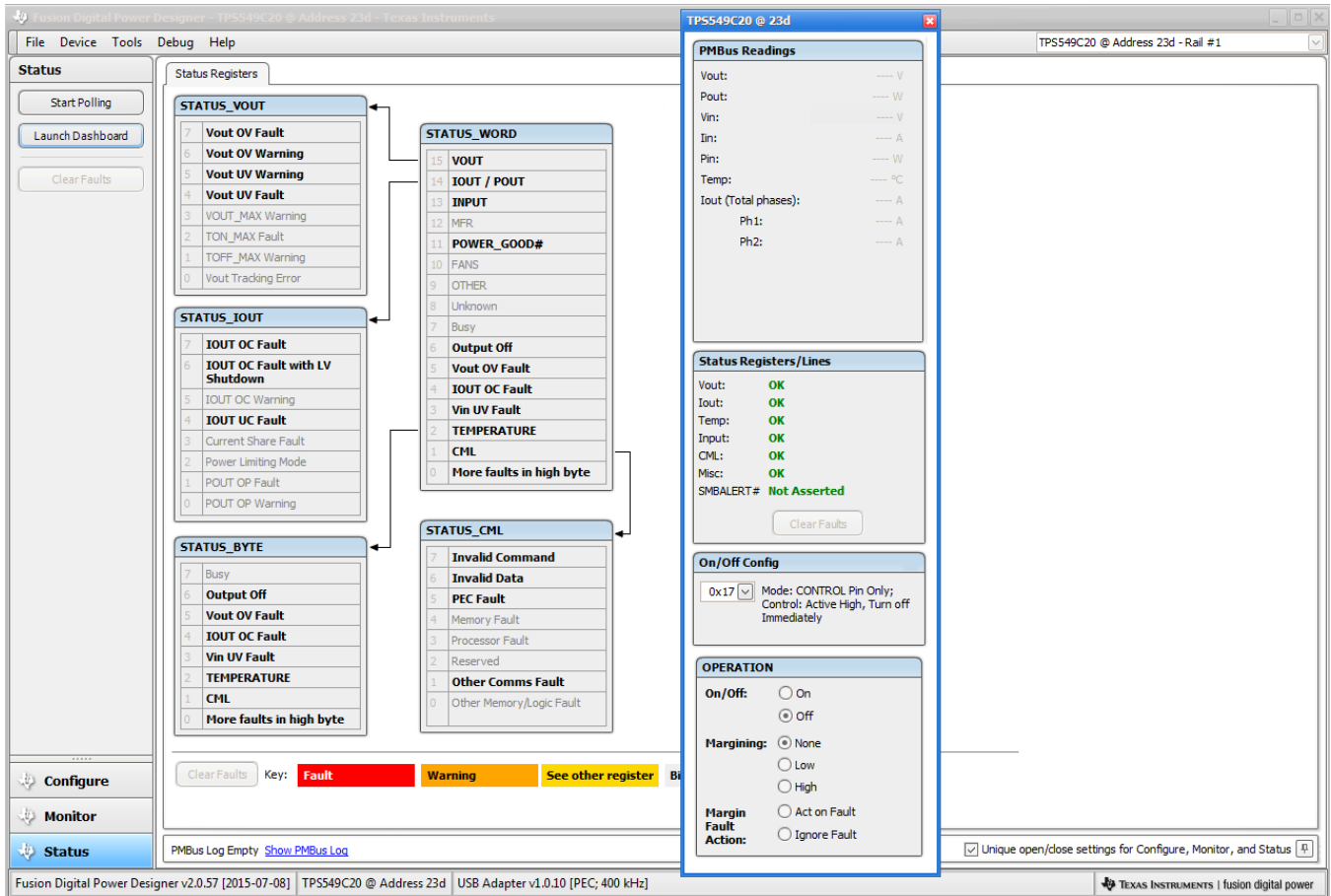


Figure 29. System Dashboard

Selecting *Status* from lower left corner shows the status of the controller (Figure 30).

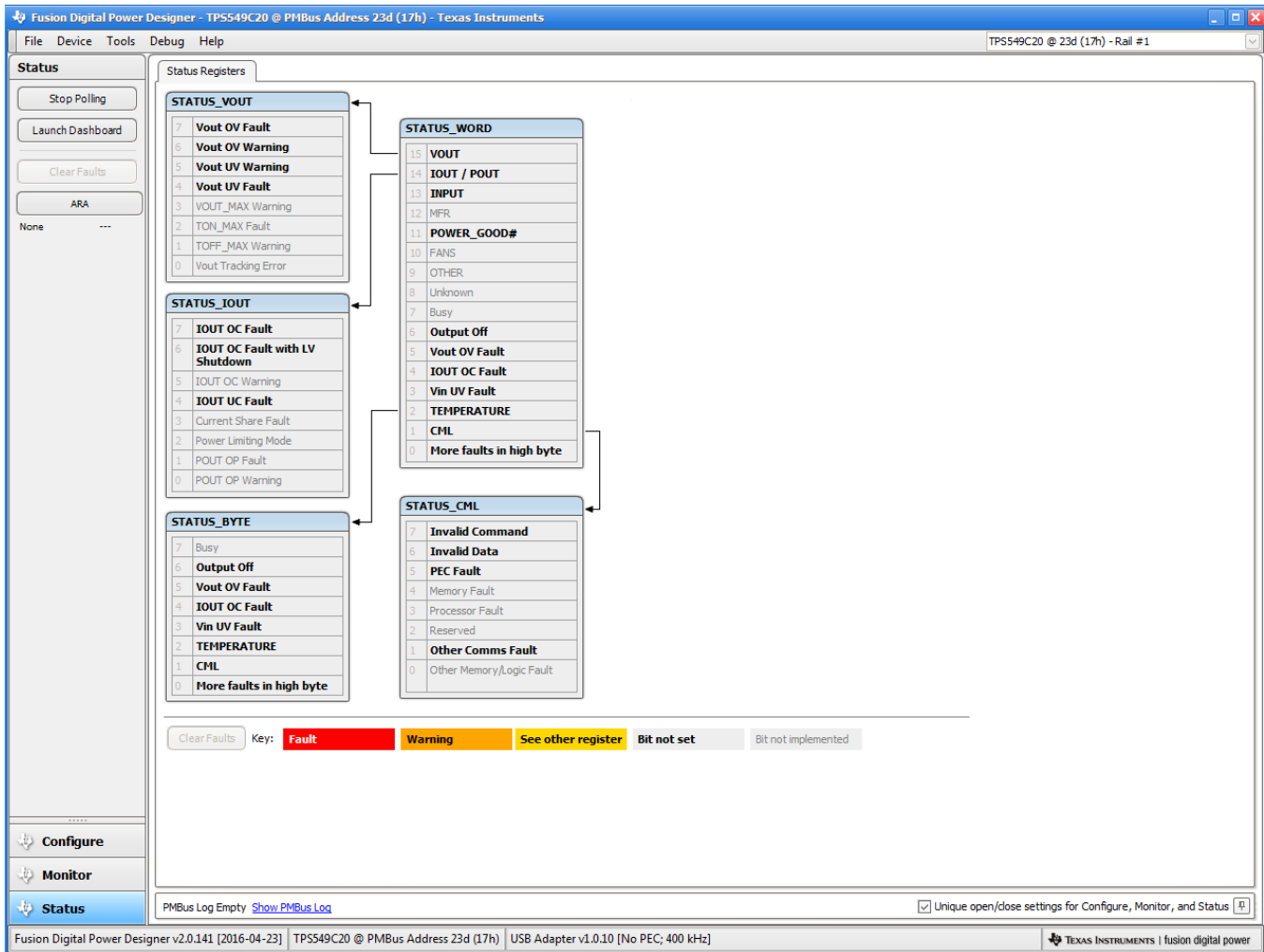


Figure 30. Status Screen

Selecting *Store User Configuration to Flash Memory* from the device pull-down menu has the same functionality as the *Store Config to NVM* button from the configure screen. It results in committing the current configuration to nonvolatile memory (Figure 31).

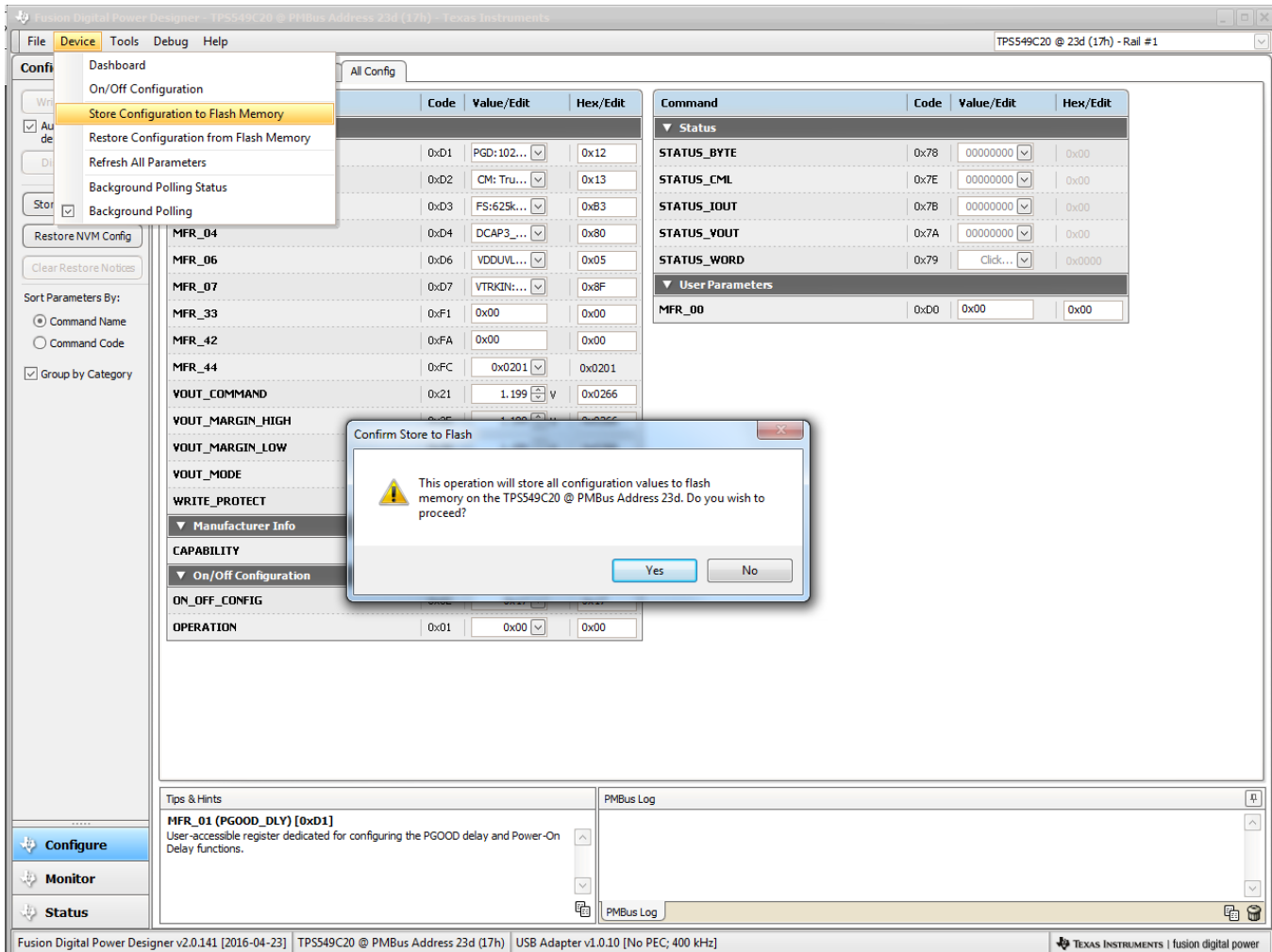


Figure 31. Store Configuration To Memory

Selecting *PMBus Logging* (Figure 32) from the Tools drop-down menu enables the logging of all PMBus activity. This includes communications traffic for each polling loop between the GUI and the device. The user is prompted to select a location for the file to be stored. See next screen (Figure 33).

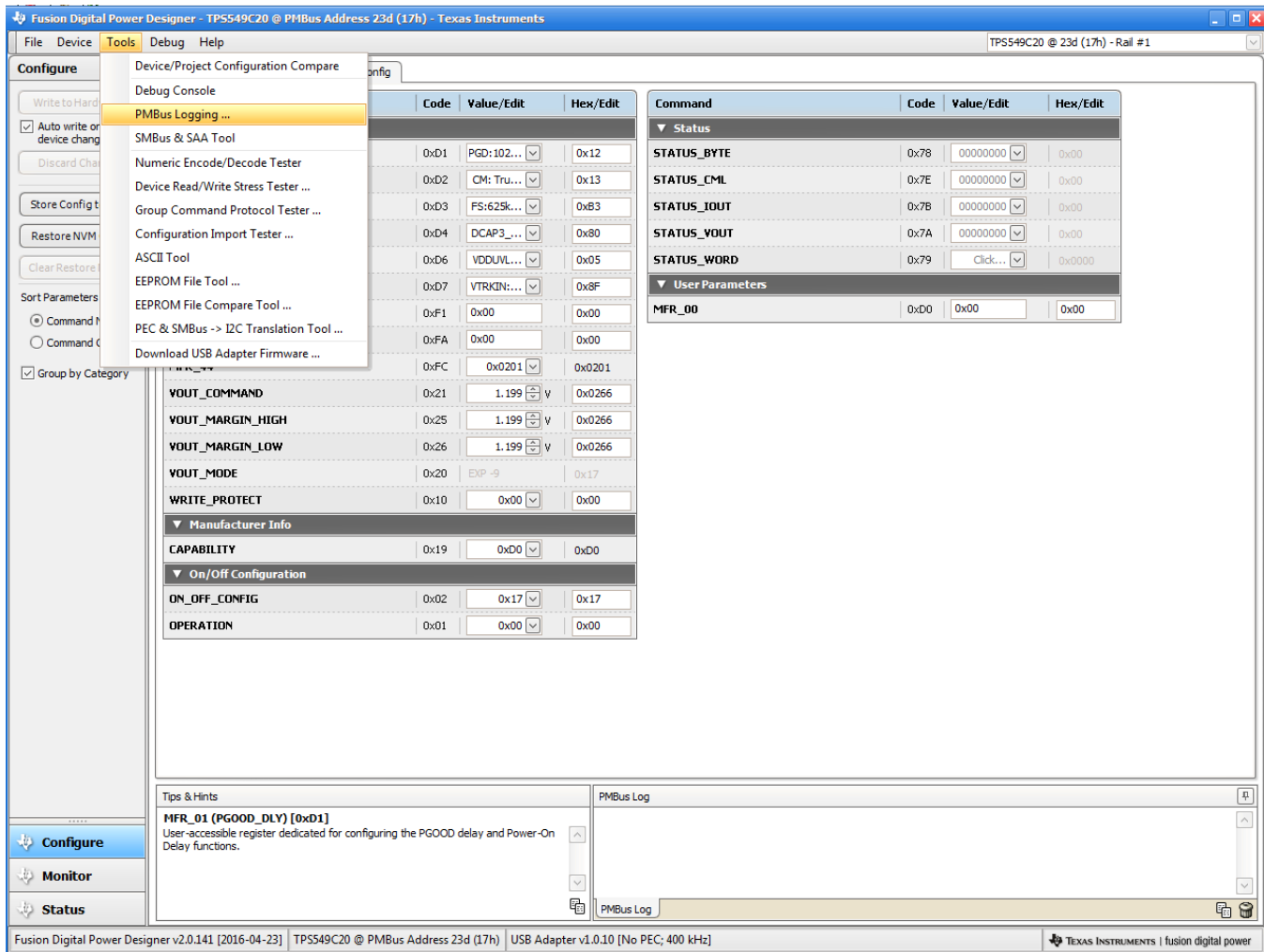


Figure 32. PMBus Logging

Select the storage location for the file and the type of file. As shown (Figure 33), the file is a CSV file to be stored in the directory path shown. Logging begins when the *Start Logging* button is selected, and stops when it is reselected (as *Stop Logging*). This file can rapidly grow in size, so caution is advised when using this function.

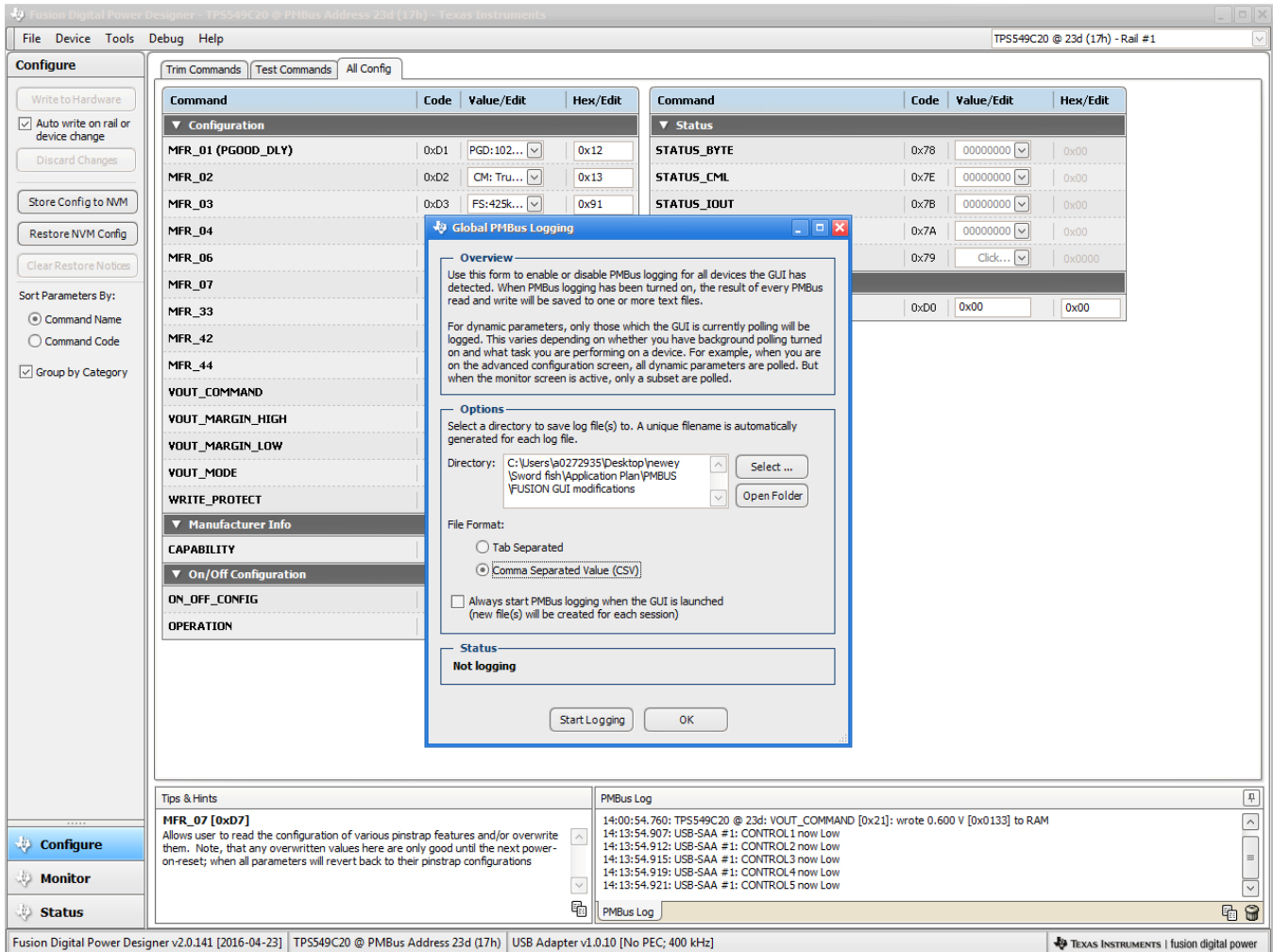


Figure 33. PMBus Log Details

13 EVM Assembly Drawing and PCB Layout

Figure 34 through Figure 41 show the design of the PWR-784EVM printed-circuit board (PCB). The PWR-784EVM has a 2-oz. copper finish for all layers.

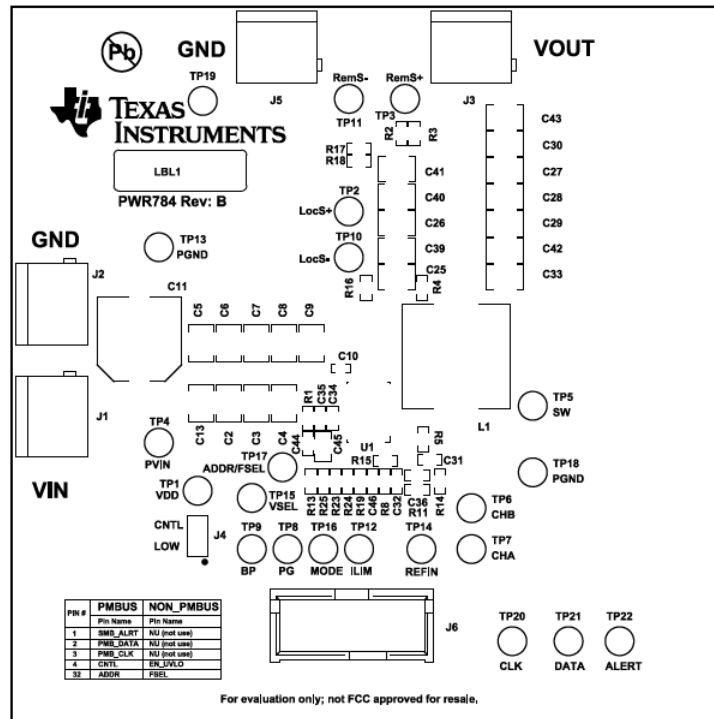


Figure 34. PWR-784EVM Top Layer Assembly Drawing (Top View)

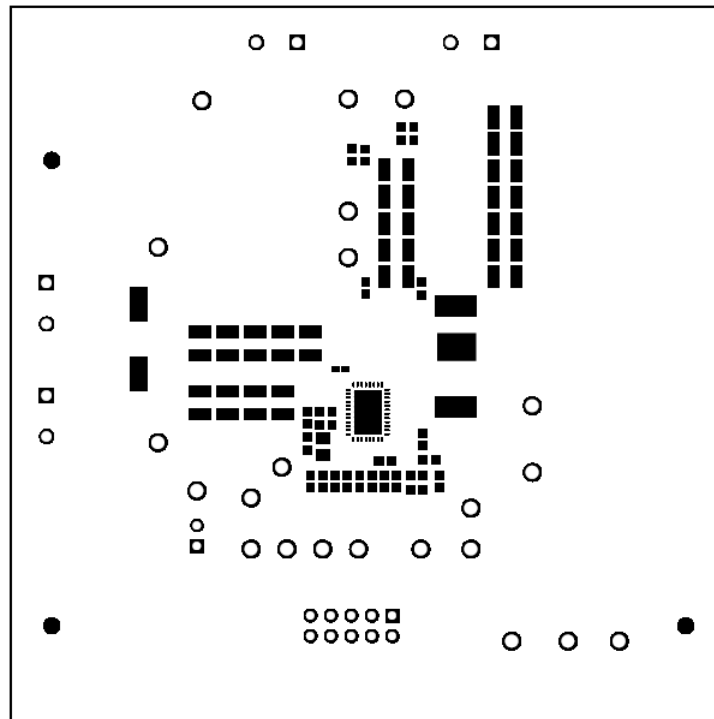


Figure 35. PWR-784EVM Top Solder Mask (Top View)

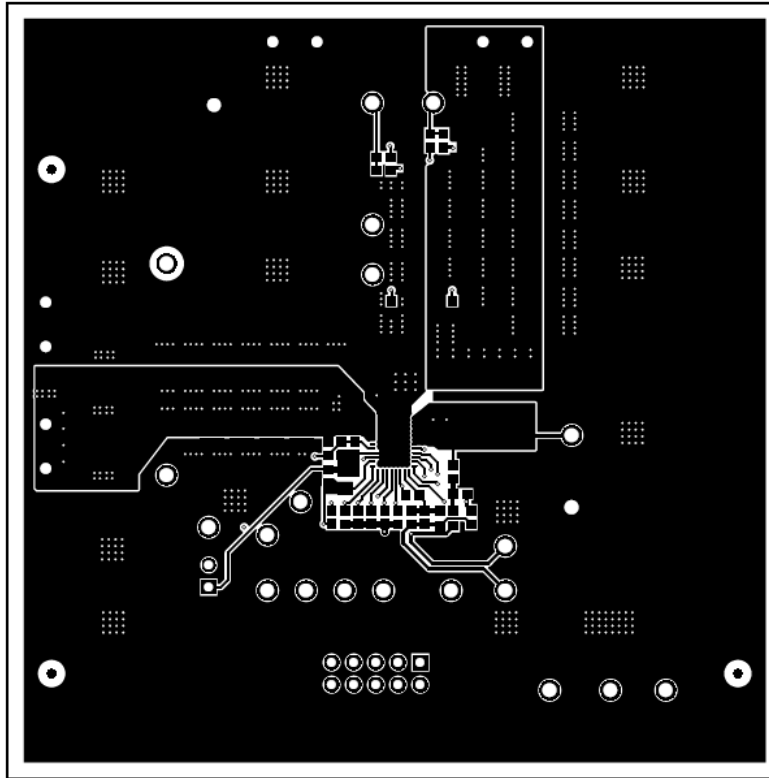


Figure 36. PWR-784EVM Top Layer (Top View)

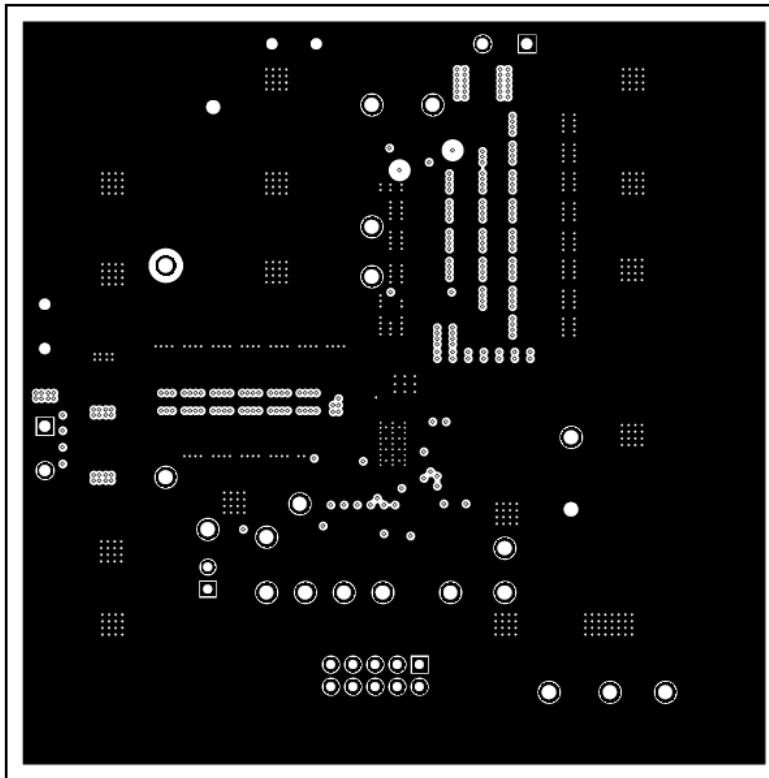


Figure 37. PWR-784EVM Inner Layer 1 (Top View)

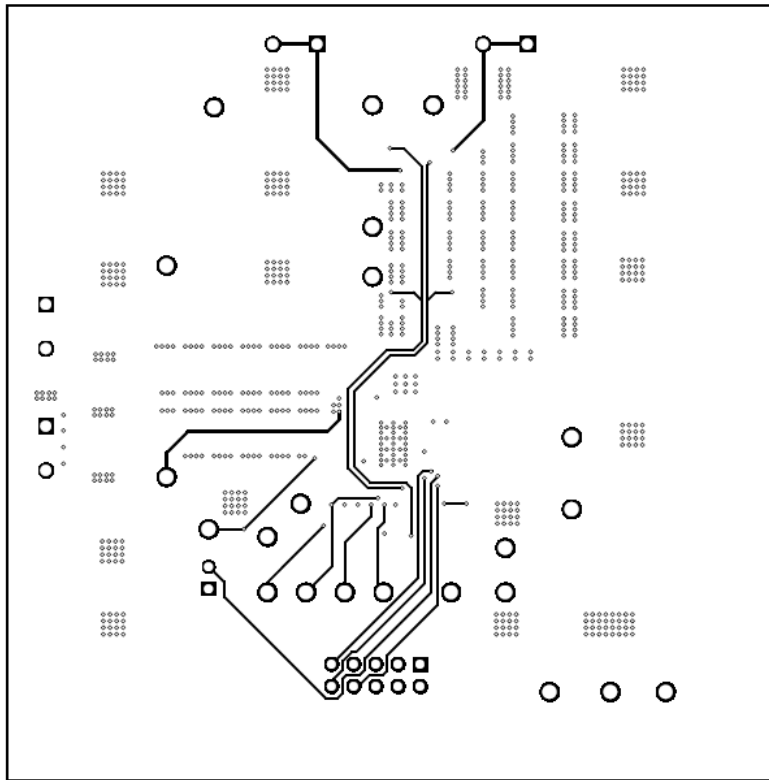


Figure 38. PWR-784EVM Inner Layer 2 (Top View)

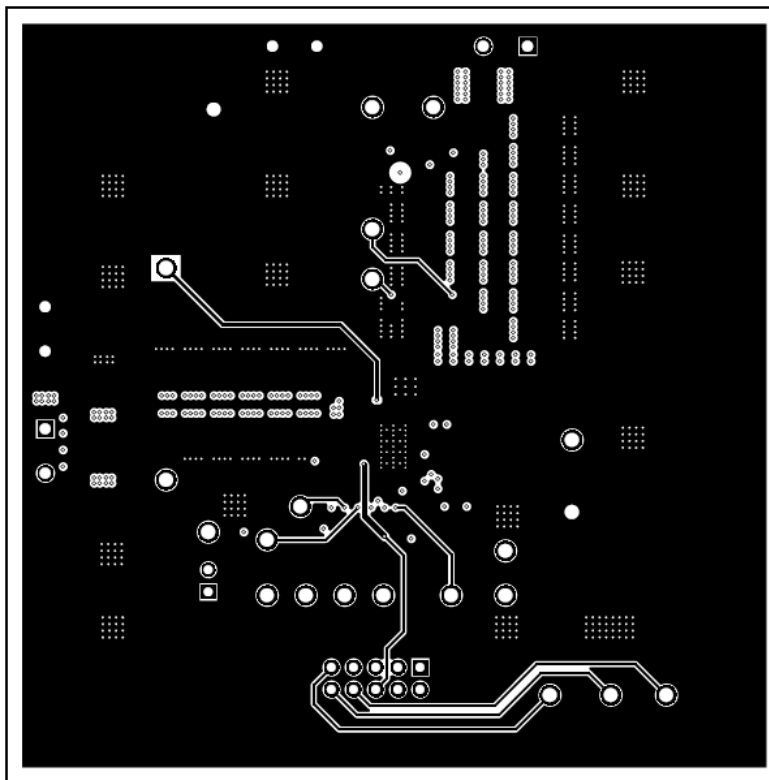


Figure 39. PWR-784EVM Inner Layer 3 (Top View)

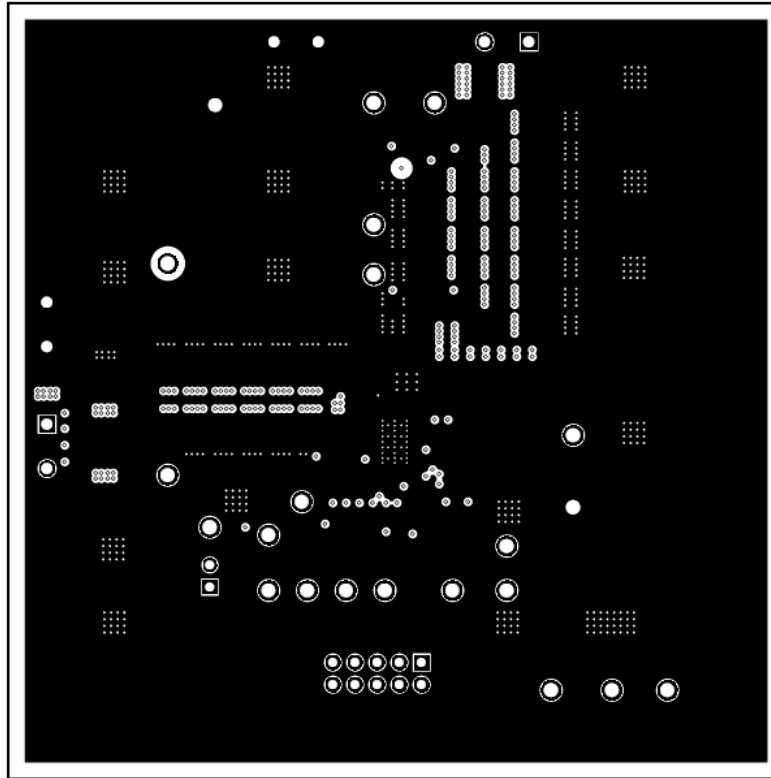


Figure 40. PWR-784EVM Inner Layer 4 (Top View)

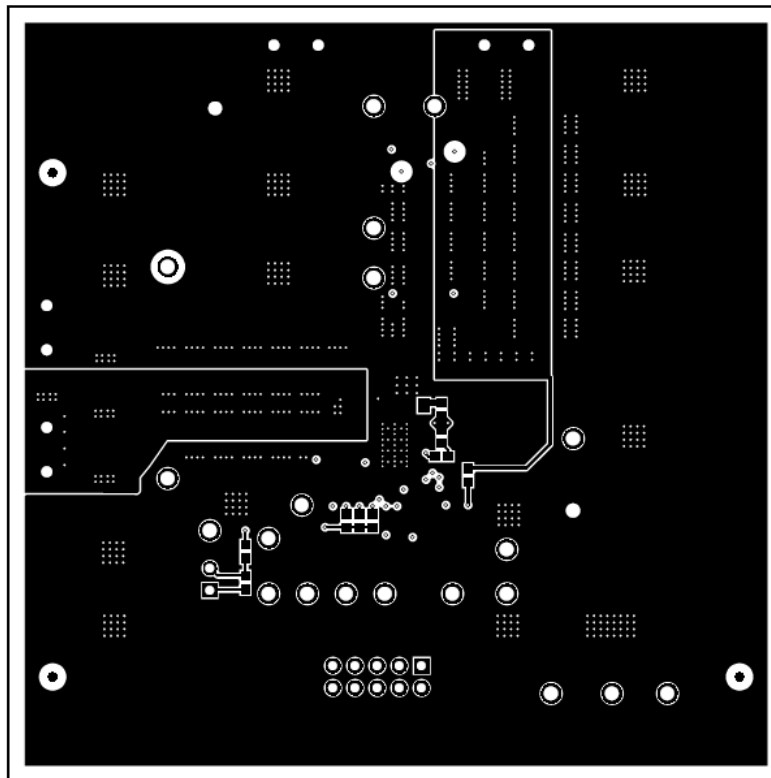


Figure 41. PWR-784EVM Bottom Layer (Top View)

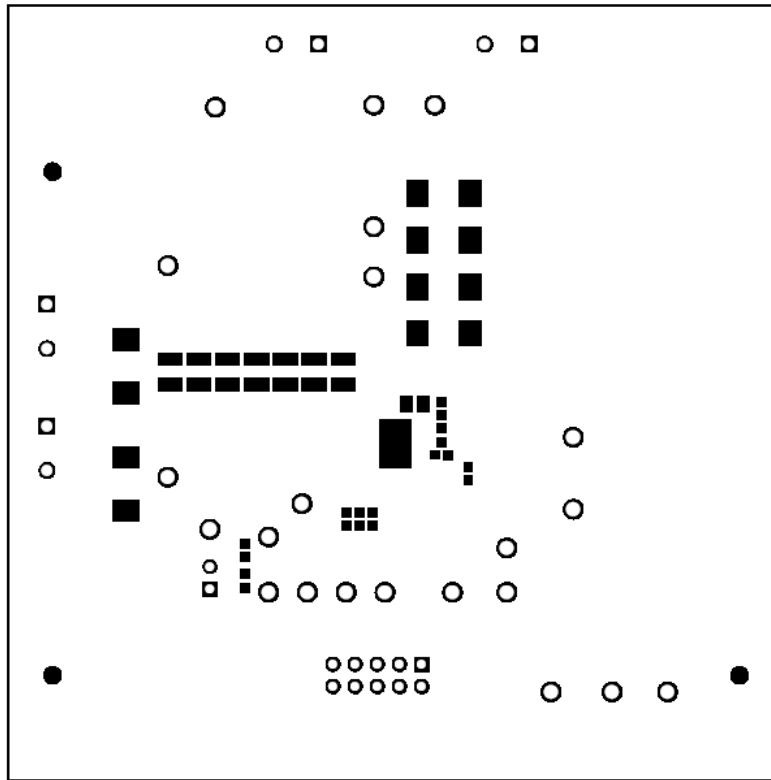


Figure 42. PWR-784EVM Bottom Solder Mask (Top View)

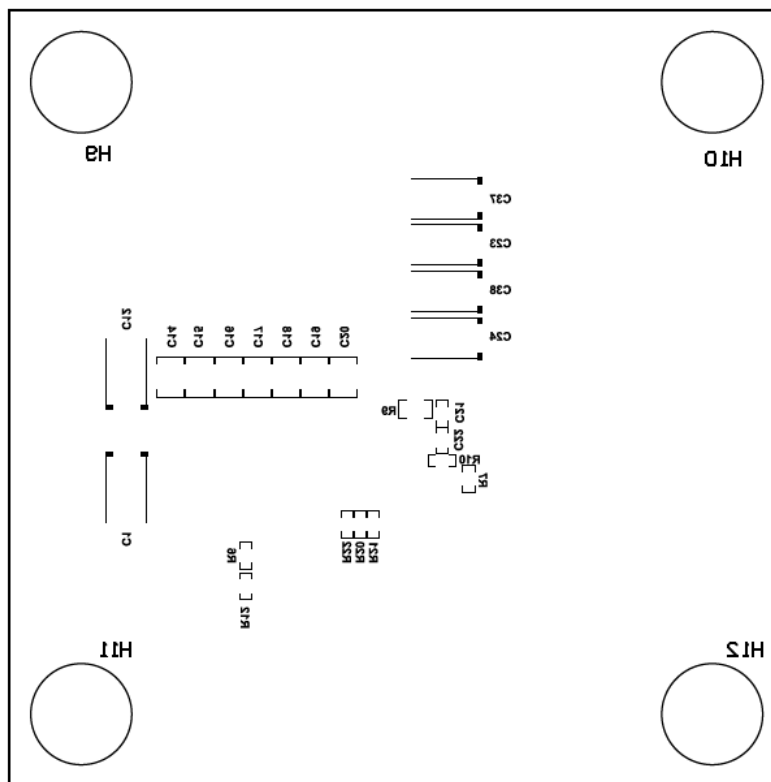


Figure 43. PWR-784EVM Bottom Overlay Layer (Top View)

14 List of Materials

The EVM components list, according to the schematic, is shown in [Table 6](#).

Table 6. PWR784 List of Materials

| Designator | Qty | Value | Description | Package Reference | Part Number | Manufacturer |
|--|-----|--------|---|------------------------------|--------------------|-----------------------------|
| !PCB1 | 1 | | Printed Circuit Board | | PWR784 | Any |
| C2, C3, C4, C5, C6, C7, C8, C9, C13, C18, C19, C20 | 12 | 22uF | CAP, CERM, 22 µF, 25 V, +/- 10%, X7R, 1210 | 1210 | GRM32ER71E226KE15L | Murata |
| C10 | 1 | 2200pF | CAP, CERM, 2200 pF, 25 V, +/- 10%, X5R, 0402 | 0402 | GRM155R61E222KA01D | Murata |
| C11 | 1 | 100uF | CAP, AL, 100uF, 35V, +/-20%, 0.15 ohm, SMD | SMT Radial G | EEE-FC1V101P | Panasonic |
| C22 | 1 | 0.1uF | CAP, CERM, 0.1 µF, 50 V, +/- 10%, X7R, 0603 | 0603 | GRM188R71H104KA93D | Murata |
| C23, C24, C38 | 3 | 470uF | CAP, Tantalum Polymer, 470 µF, 2.5 V, +/- 20%, 0.006 ohm, 7.3x2.8x4.3mm SMD | 7.3x2.8x4.3mm | 2R5TPF470M6L | Panasonic |
| C25, C26, C27, C28, C29, C33, C39, C40, C41, C42 | 10 | 100uF | CAP, CERM, 100 µF, 6.3 V, +/- 20%, X5R, 1210 | 1210 | GRM32ER60J107ME20L | Murata |
| C35 | 1 | 1uF | CAP, CERM, 1 µF, 16 V, +/- 10%, X5R, 0603 | 0603 | C0603C105K4PACTU | Kemet |
| C45 | 1 | 4.7uF | CAP, CERM, 4.7 µF, 16 V, +/- 10%, X7R, 0805 | 0805 | GRM21BR71C475KA73L | Murata |
| H9, H10, H11, H12 | 4 | | Bumpon, Hemisphere, 0.44 X 0.20, Clear | Transparent Bumpon | SJ-5303 (CLEAR) | 3M |
| J1, J2, J3, J5 | 4 | | TERMINAL BLOCK 5.08MM VERT 2POS, TH | TERM_BLK, 2pos, 5.08mm | ED120/2DS | On-Shore Technology |
| J4 | 1 | | Header, 100mil, 2x1, Tin, TH | Header, 2 PIN, 100mil, Tin | PEC02SAAN | Sullins Connector Solutions |
| J6 | 1 | | Header (shrouded), 100mil, 5x2, Gold, TH | 5x2 Shrouded header | 5103308-1 | TE Connectivity |
| L1 | 1 | 250nH | Inductor, Shielded Drum Core, Ferrite, 250 nH, 50 A, 0.000165 ohm, SMD | 12.5x13mm | 744309025 | Würth Elektronik |
| LBL1 | 1 | | Thermal Transfer Printable Labels, 0.650" W x 0.200" H - 10,000 per roll | PCB Label 0.650"H x 0.200"W | THT-14-423-10 | Brady |
| R1 | 1 | 1.00 | RES, 1.00, 1%, 0.1 W, 0603 | 0603 | RC0603FR-071RL | Yageo America |
| R4, R7, R10, R11, R16, R25 | 6 | 0 | RES, 0, 5%, 0.1 W, 0603 | 0603 | CRCW06030000Z0EA | Vishay-Dale |
| R6 | 1 | 200k | RES, 200 k, 1%, 0.1 W, 0603 | 0603 | CRCW0603200KFKEA | Vishay-Dale |
| R8 | 1 | 1.10k | RES, 1.10 k, 1%, 0.1 W, 0603 | 0603 | CRCW06031K10FKEA | Vishay-Dale |
| R12, R13, R20, R21, R22 | 5 | 100k | RES, 100 k, 1%, 0.1 W, 0603 | 0603 | CRCW0603100KFKEA | Vishay-Dale |
| R15 | 1 | 10.0k | RES, 10.0k ohm, 1%, 0.1W, 0603 | 0603 | CRCW060310K0FKEA | Vishay-Dale |
| R19 | 1 | 137k | RES, 137 k, 1%, 0.1 W, 0603 | 0603 | CRCW0603137KFKEA | Vishay-Dale |
| R23 | 1 | 37.4k | RES, 37.4 k, 1%, 0.1 W, 0603 | 0603 | CRCW060337K4FKEA | Vishay-Dale |
| R24 | 1 | 42.2k | RES, 42.2 k, 1%, 0.1 W, 0603 | 0603 | CRCW060342K2FKEA | Vishay-Dale |
| TP1, TP5, TP6, TP7, TP8, TP9, TP12, TP14, TP15, TP16, TP17, TP20, TP21, TP22 | 14 | White | Test Point, Multipurpose, White, TH | White Multipurpose Testpoint | 5012 | Keystone |
| TP2, TP3, TP4 | 3 | Red | Test Point, Multipurpose, Red, TH | Red Multipurpose Testpoint | 5010 | Keystone |

Table 6. PWR784 List of Materials (continued)

| Designator | Qty | Value | Description | Package Reference | Part Number | Manufacturer |
|------------------------------------|-----|--------|--|------------------------------|--------------------|-------------------|
| TP10, TP11, TP13, TP18, TP19 | 5 | Black | Test Point, Multipurpose, Black, TH | Black Multipurpose Testpoint | 5011 | Keystone |
| U1 | 1 | | High Performance, 40-A Single Synchronous Step-Down Converter with PMBus, RVF0040A | RVF0040A | TPS549D22RVF | Texas Instruments |
| C1, C12 | 0 | 330uF | CAP, TA, 330 μ F, 6.3 V, +/- 20%, 0.025 ohm, SMD | 7.3x2.8x4.3mm | 6TPE330ML | Sanyo |
| C14, C15, C16, C17 | 0 | 22uF | CAP, CERM, 22 μ F, 25 V, +/- 10%, X7R, 1210 | 1210 | GRM32ER71E226KE15L | Murata |
| C21 | 0 | 470pF | CAP, CERM, 470 pF, 50 V, +/- 10%, X7R, 0603 | 0603 | GRM188R71H471KA01D | Murata |
| C30, C43 | 0 | 100uF | CAP, CERM, 100 μ F, 6.3 V, +/- 20%, X5R, 1210 | 1210 | GRM32ER60J107ME20L | Murata |
| C31 | 0 | 0.1uF | CAP, CERM, 0.1 μ F, 50 V, +/- 10%, X7R, 0603 | 0603 | GRM188R71H104KA93D | Murata |
| C32 | 0 | 6800pF | CAP, CERM, 6800 pF, 50 V, +/- 10%, X7R, 0603 | 0603 | GRM188R71H682KA01D | Murata |
| C34, C44 | 0 | 1uF | CAP, CERM, 1 μ F, 16 V, +/- 10%, X5R, 0603 | 0603 | C0603C105K4PACTU | Kemet |
| C36 | 0 | 1000pF | CAP, CERM, 1000 pF, 25 V, +/- 10%, X7R, 0603 | 0603 | GRM188R71E102KA01D | Murata |
| C37 | 0 | 470uF | CAP, Tantalum Polymer, 470 μ F, 2.5 V, +/- 20%, 0.006 ohm, 7.3x2.8x4.3mm SMD | 7.3x2.8x4.3mm | 2R5TPF470M6L | Panasonic |
| C46 | 0 | 1000pF | CAP, CERM, 1000 pF, 50 V, +/- 5%, COG/NP0, 0603 | 0603 | C0603C102J5GACTU | Kemet |
| FID1, FID2, FID3, FID4, FID5, FID6 | 0 | | Fiducial mark. There is nothing to buy or mount. | Fiducial | N/A | N/A |
| R2, R3, R14, R17, R18 | 0 | 0 | RES, 0, 5%, 0.1 W, 0603 | 0603 | CRCW06030000Z0EA | Vishay-Dale |
| R5 | 0 | 1.50k | RES, 1.50 k, 1%, 0.1 W, 0603 | 0603 | RC0603FR-071K5L | Yageo America |
| R9 | 0 | 3.01 | RES, 3.01 ohm, 1%, 0.125W, 0805 | 0805 | CRCW08053R01FKEA | Vishay-Dale |

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This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

FCC Interference Statement for Class A EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

FCC Interference Statement for Class B EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

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Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes: (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

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Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication. This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

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Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante. Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur.

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2. Use EVMs only after User obtains the license of Test Radio Station as provided in Radio Law of Japan with respect to EVMs, or
3. Use of EVMs only after User obtains the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to EVMs. Also, do not transfer EVMs, unless User gives the same notice above to the transferee. Please note that if User does not follow the instructions above, User will be subject to penalties of Radio Law of Japan.

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4.3 *Safety-Related Warnings and Restrictions:*

4.3.1 User shall operate the EVM within TI's recommended specifications and environmental considerations stated in the user guide, other available documentation provided by TI, and any other applicable requirements and employ reasonable and customary safeguards. Exceeding the specified performance ratings and specifications (including but not limited to input and output voltage, current, power, and environmental ranges) for the EVM may cause personal injury or death, or property damage. If there are questions concerning performance ratings and specifications, User should contact a TI field representative prior to connecting interface electronics including input power and intended loads. Any loads applied outside of the specified output range may also result in unintended and/or inaccurate operation and/or possible permanent damage to the EVM and/or interface electronics. Please consult the EVM user guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative. During normal operation, even with the inputs and outputs kept within the specified allowable ranges, some circuit components may have elevated case temperatures. These components include but are not limited to linear regulators, switching transistors, pass transistors, current sense resistors, and heat sinks, which can be identified using the information in the associated documentation. When working with the EVM, please be aware that the EVM may become very warm.

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